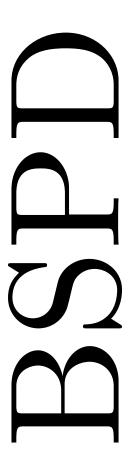
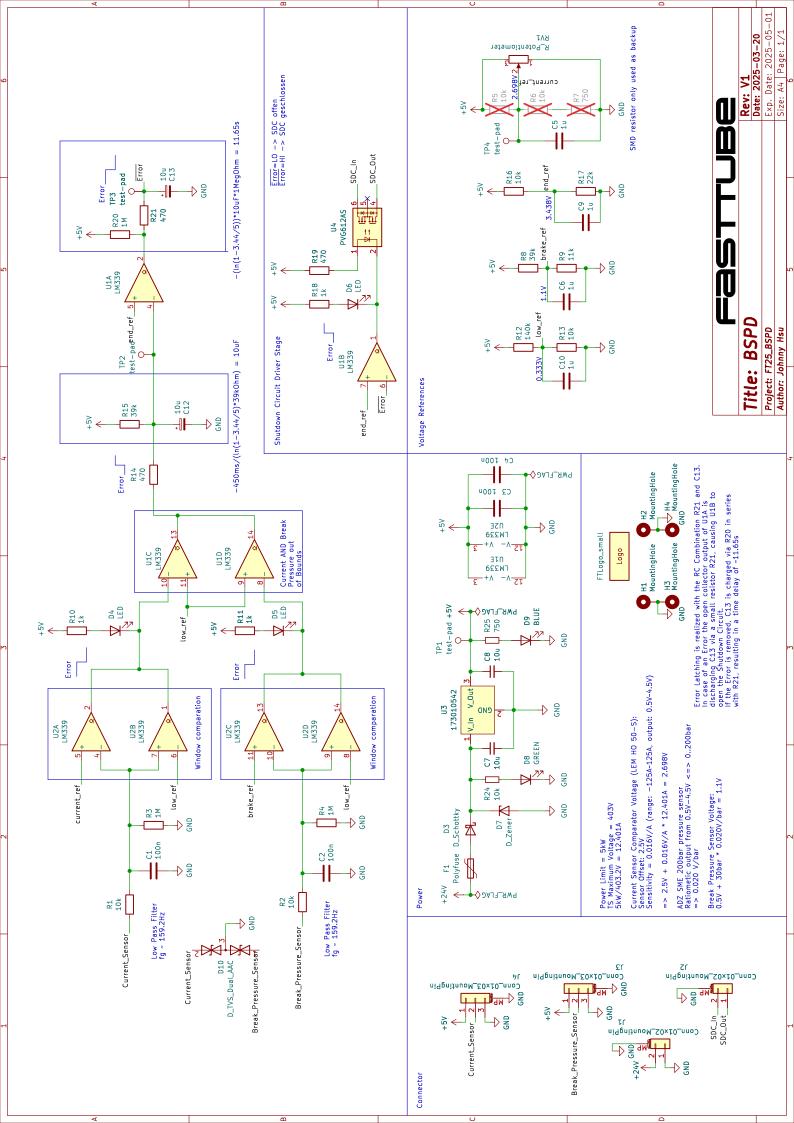
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BEDIENUNGSANLEITUNG

Drucktransmitter in Miniturbauform

Baureihe SME

Einbau und Inbetriebnahme sind nach dieser Bedienungsanleitung und nur von autorisiertem Personal vorzunehmen.





ADZ NAGANO GmbH Geslishaff für Sensortechnik Bergener Ring 43 in 32005 (Assortecent) 01 458 Ottendorf-Okrilla, Germany Telefor, +48 (0) 32005 (59 69-39 Telefor, +48 (0) 3205 (59 69-59 E-Mail; info@atc.de nternet: www.adz.de



(Abbildung ähnlich)

Pressure Transmitter in Miniature Design

OPERATING INSTRUCTIONS

SME Series

This product must be installed and taken into operation in accordance with these Operating Instructions and by authorized personnel only.



62 MAGANO Sensortechnik

ADZ NAGANO GmbH Geslischaff für Sensortechnik Bergener Ring 43 01458 Ottendorf-Okrilla, Germany Phone: +49 (0) 35205 / 59 69-59 E-mall: info@adszde Internet: www.adz.de

(similar image)

Transmetteur de pression dans la conception miniature

MANUEL D'UTILISATION

Gamme SME

L'installation et la mise en marche sont à réaliser conformément aux instructions décrites dans ce manuel d'utilisation et exclusivement par un personnel certifie.

(Représentation similaire)

62/AGANO

ADZ NAGANO GmbH
Geelkohff für Sensortechnik
Bergener Ring 43
01450 Ottendor-Okrilla, Germany
Teleiphore: +49 (0) 32005 | 59 69-30
Teleiphore: +49 (0) 32005 | 59 69-30
E-Mail: info@adzote

Données techniques *

Radiometric 0,5...4,5 V_{pc} 5 V_{oc} ±10% > 4,7 KΩ

Voltage

lype

radiometrisch 0,5...4,5 V_{oc} 5 V_{oc} ±10%

Spannung

Spannung

ᇫ

Technische Daten *

0...5 V_{pc} 8...32 V_{DC}

Ausgangssignal*

Technical specifications *

voltage

< 0,5% full scale at room temperature

> 2,5 KΩ

8...32 V_{pc}

Operating voltage (U_s)

Admissible load

> 4,7 KΩ

> 2,5 KΩ

Betriebsspannung (U_a)

Lastwiderstand (R,)

zulässiger

Gena uig keit* Druckbereich

≤ 0,5% full scale bei Raumtemperatur

siehe Typenschild

0...5 V_{pc}

output signal*

See type plate

Time of adjustment*

Pressure range resistance (R,)

Precision*

Temperature range

-40...125°C measuring medium ~20 g (dependent on version) (thread, electrical connection, etc.) IP67 for flange plug M5x0,5 / cable

Dependent on design -40...85°C ambient

Dimensions

Weight

~20 g (abhängig von der Ausführung)

Gewicht

-40...125°C Messmedium -40...85°C Umgebung

Temperaturbereich*

Einstellzeit

Membrane: stainless steel

Housing: stainless steel

IP protection class*

IP67 bei Flanschstecker M5x0,5 / Kabel

IP Schutzklasse Abmessungen

Membran: Edelstahl Gehäuse: Edelstahl

(Gewinde, elektr. Anschluss, usw.) Abhängig von der Bauform

Material applied*

Туре	Tension	Tension
		quotientométrique
Signal de sortie*	²⁰ Λ 50	0,54,5 V _{oc}
Tension d'utilisation (U _a)	832 V _{oc}	5 V _{pc} ±10%
Impédance admise	> 2,5 KΩ	> 4,7 KΩ
de charge (R.)		
Précision*	≤ 0,5% de la déviation max. à température ambiante	à température ambiante
Classe de pression	Voir la plaquette indicatrice	
Temps de réponse*	< 1 ms	
Gamme de température*	-40125°C fluide de mesure	
	-4085°C conditions ambiantes	intes
Poids	~20 g (selon la mise en œuvre)	(a)
Dimensions	Selon le modèle de construction	ion
	(filet, raccord électrique, etc.)	
Classe de protection IP*	IP67 par prise femelle à bride M5x0,5 / câble	M5x0,5 / câble
Matéria u*	Boîtier : acier inoxydable	
	Membrane: acier inoxydable	

Anschlüsse *

Kabelausgang

Cable port

Power

red: UB+ black: UB-white: out

Connections *

rt: UB+ sw: UB-ws: out Strom

Der elektrische Anschluss muss entsprechend dem jeweiligen Anschlussschema erfolgen, soweit keine anderen vereinbart wurden.

* Kundenspezifische Anpassungen sind realisierbar.

Sortie du câble	Tension	rouge: UB+ noir: UB- blanc: out

Raccords *

ge: UB+ : UB-nc: out sion

Les raccords électriques doivent se faire conformément au schéma concerné, sauf accords différents.

The electrical connection must be made in accordance with the respective connection diagram unless otherwise agreed upon.

* Custom-made adjustments are possible.

* Modifications possibles, à la demande du client.

La clasce de protection (PGE/IPGT* n'est pas transférable à toutes les conditions ambiantes anns testriction. Les ut classification contraint pour un bobier connecte Il reviert à l'utilisateur de vérifire si le raccordement utilisé correspond à d'a autres dispositions et élémentalions en eties indiques etéle utilisations contraint de lettre mployé pour des utilisations getélates, non prévues par nous. Veillez à respecter les valeurs limites indiquées dans ce manuel et/ou dans la fiche technique pour ce qui est par ex. des pressions, des forces et des températures. L'ensemble du câblage doit respecter les réglementations locales et ne peut être réalisé que par un presonne l'erefifié. Il authérine la distincion entre lignes à haure et à basse tension. Utilises un câble adapté à l'environnement. La connexion électifique doit se faire en respectant le schéma correspondant, Prenez garde à ce que toutes les gamitures d'étanchéité soient en bon état et à ce que le montage soit adéquat, sans quoi la classe de protection IP ne peut être gannitie. Les données fournies par la fiche technique pour la sécurité surpression (domaine de surcharge et/ou pression de rupture) se référent au composant du transmetteur de pression qui est soumis à une pression hydraulique et/ou pneumatique. Utilisez, pour étanchéffier le système, le joint d'étanchéité prévu pour le modèle et aux dimensions adaptées. Recyclage Utilisez la bonne clé pour visser le transmetteur de pression dans le connecteur côté refoulement prévu à cet effet. Le couple de serrage est d'environ 10 Nm. Lors de l'installation et de l'utilisation du transmetteur de pression électronique, respectez le réglementations BG / les consignes de prévention des accidents du tavail de la profession, du Service d'Inspection Technique (IUV) ou les réglementations nationales correspondantes, proprès à voire paps. Suivez à la lettre les recommandations et les mises en garde contenues dans ce manuel. N'util sez le transmetteur de pression que dans son état d'origine. N'entreprenez aucune modification vous-même sur l'appareil. L'appareil ne contient aucun composant qui nécessite un quelconque entretien. Retirez l'appareil de tout emballage de transport ou de protection avant de vous en servir (films plastique, couvercles ou cartonnage par \exp). Recommandations générales à toujours respecter pour une utilisation adaptée et sécurisée du transmetteur de pression électronique: Tenez compte des conditions ambiantes (température, pression atmosphérique, humidité, etc.). Des variations par rapport aux conditions ambiantes mentionnées dans la fiche rechnique (la déviation de température par exemple) peuvent endommager le transmetteur de pression. Les transmetteur de pression électroniques de la gamme SME sont conçus pour mesurer la pression au sein d'installations et de systèmes contenant des fluides sous forme gazeuse ou liquide. Prenez garde à respecter les consignes de sécurité propres au démontage du transmetteur de pression N'exposez jamais le produit à de fortes vibrations ou à des chocs intenses. Attention à ce que les câbles ne soient pas écrasés sur leur trajectoire. sauf accords différents. Sans quoi on peut assister à une défaillance/détérioration du produit. Le système de pression ne doit être soumis à aucune pression lors du démontage. Sous réserve de modifications servant le progrès technique. État: Décembre-2010 Rév. 1 Jetez les matériaux dans des réservoirs collecteurs de recyclage. Danger Danger Remarque Attention Démontage du transmetteur de pression Montage du transmetteur de pression Conditions d'utilisation du produit Conditions d'utilisation h Légende \triangleleft ∢ \triangleleft When installing and taking into operation the pressure transmitter, please observe the accelent prevention regulations as defined by the German Satutory Accident Insurance, by the German technical service corporation TUV or pursuant to the national regulations applicable in your country. Notes generally to be borne on the proper and safe use of the pressure transmitter: The Protection class [P65/H65**] is not absolutely transferable to any ambient condition. They apply fin not stated other wisely with its counter-plug connected. It is the user's liability to check whether the connection applied corresponds with regulations and provisions other than those specified owhether spous connection can be used in special applications that cannot be anticipated by us. The values quoted in the technical data sheet for excess pressure safety (excess load range or burst pressure) refer to the hydraulically or pneumatically exposed part of the pressure transmitter. Deviations from the ambient conditions as specified in the technical data sheet (such as the **temperature range**) may result in damage to the pressure transmitter. Recycling Recycling Before taking it into operation, remove all transit or protection packaging (e.g. protective film, caps or cardboard packaging. Use the pressure transmitter in its original state only. Do not tamper with the product. The device contains no components that would require any Observe the notes and warnings of these operating instructions by all means. Please observe the limit values defined in these Operating Instructions or the technical specification sheets, such as pressure, force and temperature. Provide for correctly positioning all seals and for appropriate assembly, since otherwise the IP protection class cannot be warranted. Please consider the prevailing ambient conditions (temperature, air pressure, humidity, etc.). Pressure transmitters of the SME series are suited for measuring pressure in plants and systems with gaseous and liquid media. The entire wining must meet local regulations and must be performed by any advoired personate only. It light and low voltage times are to be kept separate. Use cable that is appropriate to the installation environment. Exercise power must be connected in accordance with the respective connection diagram, unless otherwise, agreed upon. Damageldestruction may result otherwise. Please observe applicable safety regulations when removing the pressure transmitter. For sealing the system, use the sealing ring of the respective dimensions specified for this type. Use an appropriate wrench to insert the pressure transmitter into the respective pressure connection. The torque is approximately 10 Nm. Dispose of the various materials by returning them to recycling banks. When disassembling the pressure system, it must be depressurized. Never expose the product to heavy vibrations or physical impact. Subject to change due to technical progress. Reviewed last: December - 2010 Rev. 1 Danger ∢ Caution How to remove the pressure transmitter How to install the pressure transmitter Requirements of product application Do not crush cables. maintenance. Operating conditions Signs and symbols Note \triangleleft \triangleleft \triangleleft De gesant wedrafnstug mass den laden gestimmungen susperveren und darf nur durch autoriderte Fresonal durchgrührt werden. Herb- und Niederspan-nungsleitungen bind vonerinander zu tremen, Verwenden Sie ein dem Umfeld einsprechendes Sheld. Der erkfrische Anstein muss entsprechend den jewei-ligen Anschlüssschem arfolgen, soweit keine anderen vereinbart wurden. Ansonsten im er sum Andalfzersdowing tillnen. Berücksichten Sie die vorherischenden Umgebungsbedingungen (Temperatur, Luftdruck; Lufffeuchtigkeit, etc.). Die Schutzklasse IP65/IP67* ist nicht uneingeschränkt auf alle Umgebungsbedingungen gungen überdagiad. Sie gleich (wern nicht anders sangegeben) mit angeschlossenen Gegensteter. Die Uberprüfung, od iet eingesetzte Steckerbindung anderen als den angegeberen Bestimmungen und Vorschriften ertspricht bzw. ob diese in speziellen, von uns nicht vorgeseberen Anwendungen eingesetzt werden lann, obliegt dem Anwender. Achten Sie auf die Einhaltung der notwendigen Sicherheitsbestimmungen beim Ausbau des Drucktransmitters. Recycling Allgemeine, stets zu beachtende Hinweise für den ordnungsgemäßen und sicheren Einsatz des Drucktransmitters: Abweichungen von den im technischen Datenblatt angegebenen Umgebungsbe-dingungen (z.B. Temperaturbereich) können zur Beschädigung des Drucktrans-mitters führen. Die im technischen Datenblatt angegebenen Werte für die Überdrudssicherheit (Überlast Bereich bzw. Bestfurck) Beziehen sich auf den hydraulisch bzw. pneumäßeb beaufschlagten feil des Druckfransmitters. Zum Abdichten des Systems verwenden Sie den für diesen Typ vorgeschrieben Dichtungsring mit den entsprechenden Abmessungen. Benutzen Sie den passenden Schraubenschlüssel um den Drucktransmitter in den vorgesehen Druckanschluss einzuschrauben. Das Anzugsdrehmoment beträgt ungefähr 10 Nm. Verwenden Sie den Drucktransmitter nur im Originalzustand. Nehmen Sie keine eigenmächtigen Veränderungen daran vor. Das Gerät enthält keine Bauteile die Befolgen Sie unbedingt die Hinweise und Warnungen in dieser Bedienungsan-letbung. Das Drucksystem muss sich beim Demontieren in einem drucklosen Zustand befinden. Beachten Sie bei Installation und Betrieb des Drucktransmitters die BG-Vorschriffen, der Schriffen / Unfalkerhüttungsvorschriffen der Berußgenossenschaften, des Technischen Derward-ungsvereins (TÜV) oder die entsprechenden nationalen Bestimmungen Ihres Landes. Halten Sie die angegebenen Grenzwerte dieser Bedienungsanleitung bzw. des technischen Datenblattes wie z.B. Drücke, Kräfte und Temperaturen ein. Die Drucktransmitter der Baureihe SME sind für das Erfassen des Druckes in Anlagen und Systemen mit gasförmigen und flüssigen Medien geeignet. Entfernen Sie vor Inbetriebnahme alle Transport- und Schutzverpackungen (z. B. Schutzfolien, Kappen oder Kartonagen). Achten Sie auf eine korrekte Lage aller Dichtungen und eine sachgemäße Montage, da sonst die IP Schutzklasse nicht garantiert werden kann Entsorgen Sie die einzelnen Werkstoffe in Recycling-Sammelbehältern. Setzen Sie das Produkt niemals starken Vibrationen oder Stößen aus. Änderungen im Sinne des technischen Fortschritts vorbehalten. Stand: Dezember – 2010 Rev. 1 Gefahr ∢ Vorraussetzungen für den Produkteinsatz Achtung einer Wartung bedürfen. Ausbau des Drucktransmitters Einbau des Drucktransmitters Betriebsbedingungen Hinweis Zeichenerklärung \triangleleft \triangleleft \triangleleft

Series PVG612APbF

Microelectronic Power IC

HEXFET® Power MOSFET Photovoltaic Relay Single-Pole, Normally-Open, 0-60V, 2.0A AC / 4.0A DC

General Description

The PVG612A Series Photovoltaic Relay is a single-pole, normally open solid-state relay that can replace electromechanical relays in many applications. It utilizes International Rectifier's proprietary HEXFET power MOSFET as the output switch, driven by an integrated circuit photovoltaic generator of novel construction. The output switch is controlled by radiation from a GaAlAs light emitting diode (LED) which is optically isolated from the photovoltaic generator.

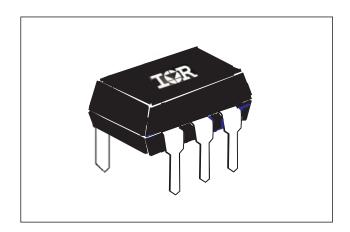
These units exceed the performance capabilities of electromechanical relays in operating life, sensitivity, stability of on-resistance, miniaturization, insensitivity to magnetic fields and ruggedess. The compact PVG612A is particularly suited for isolated switching of high currents from 12 to 48 Volt AC or DC power sources.

Series PVG612A Relays are packaged in a 6-pin, molded DIP package with either thru-hole or surface mount (gull-wing) terminals. It is available in standard plastic shipping tubes or on tape-and-reel. Please refer to Part Identification information opposite.

Features

- Bounce-free operation
- High load current capacity
- High off-state resistance
- Linear AC/DC operation
- 4,000 V_{RMS} I/O Isolation
- Solid-State reliability
- UL recognized
- ESD Tolerance:

4000V Human Body Model 500V Machine Model



Applications

- Programmable Logic Controllers
- Computers and Peripheral Devices
- Audio Equipment
- Power Supplies and Power Distribution
- Control of Displays and Indicators
- Industrial Automation

Part Identification

PVG612APbF thru-hole

PVG612ASPbF surface-mount

PVG612AS-TPbF surface-mount, tape

and reel

(HEXFET is the registered trademark for International Rectifier Power MOSFETs)



Electrical Specifications (- 40° C \leq T_A \leq + 85° C unless otherwise specified)

INPUT CHARACTERISTICS	Limits	Units
Minimum Control Current (see figure 1)	5.0	mA
Maximum Control Current for Off-State Resistance @ T _A = +25°C	0.4	mA
Control Current Range (Caution: current limit input LED, see figure 6)	5.0 - 25	mA
Maximum Reverse Voltage (1mA max.)	6.0	V

OUTPUT CHARACTERISTICS		Limits	Units
Operating Voltage Range		0 to ±60	V(DC or AC peak)
Maximum Continuous Load Current @ TA = +4	Maximum Continuous Load Current @ T _A = +40°C, 10mA Control		
(see figure 1)	A Connection	2.0	A (AC or DC)
	B Connection	2.5	A (DC)
	C Connection	4.0	A (DC)
Maximum Pulsed Load Current @ T _A =+25°C (100 ms @ 10% Duty Cycle)		
	A Connection	7.5	A (AC or DC)
	B Connection	8.5	A (DC)
	C Connection	15.5	A (DC)
Typical Thermal Resistance (Rthja, Junction-to-Ambient)			
	A Connection	79.1	(°C/W)
	B Connection	112.2	(°C/W)
	C Connection	81.0	(°C/W)
Maximum On-State Resistance @TA =+25°C			
For 1A pulsed load, 10mA Control (see figure 4)	A Connection	100	mΩ
	B Connection	50	mΩ
	C Connection	35	mΩ
Maximum Off-State Leakage @ 60V, TA =+25°C		1.0	μΑ
Maximum Turn-On Time @TA =+25°C (see figures For 500mA, 50V _{DC} load, 10mA Control, 10mS p		3.5	ms
Maximum Turn-Off Time @TA =+25°C (see figure For 500mA, 50VDC load, 10mA Control, 10mS pu		0.5	ms
Typical Output Capacitance @ Vdd=50V, f=1MHz		105	pF

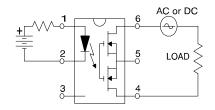
GENERAL CHARACTERISTICS		Limits	Units
Minimum Dielectric Strength, Input-Output	4000	V _{RMS}	
Minimum Insulation Resistance, Input-Output, @	10 ¹²	Ω	
Maximum Capacitance, Input-Output		1.0	pF
Maximum Pin Soldering Temperature (10 seconds maximum)		+260	
Ambient Temperature Range:	Operating	-40 to +85	°C
	Storage	-40 to +100]

International Rectifier does not recommend the use of this product in aerospace, avionics, military or life support applications. Users of this International Rectifier product in such applications assume all risks of such use and indemnify International Rectifier against all damages resulting from such use.

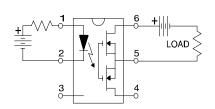


Connection Diagrams

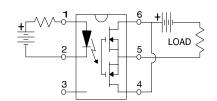
"A" Connection



"B" Connection



"C" Connection



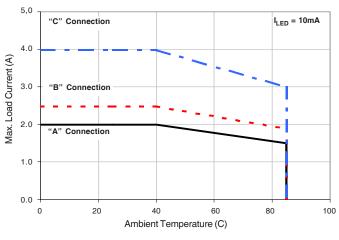
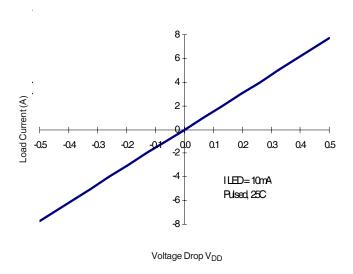


Figure 1. Current Derating Curves

Figure 2. Typical Output Capacitance



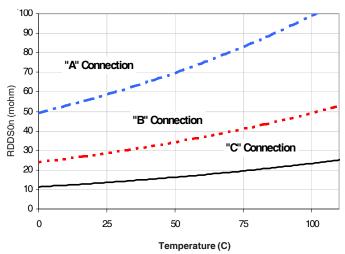


Figure 3. Typical Linearity Characteristics

Figure 4. Typical Normalized On-Resistance



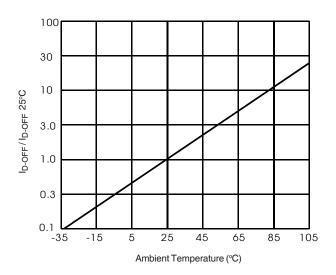


Figure 5. Typical Normalized Off-State Leakage

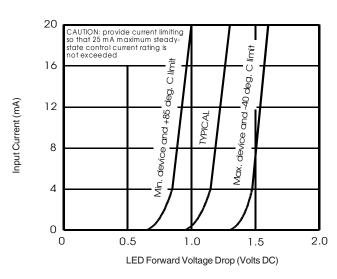


Figure 6. Input Characteristics (Current Controlled)

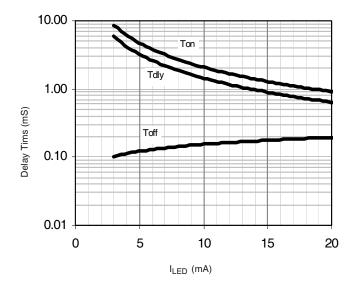


Figure 7. Typical Delay Times

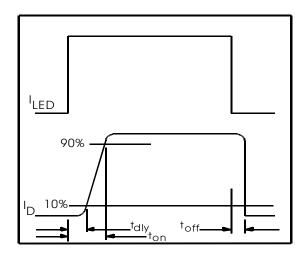
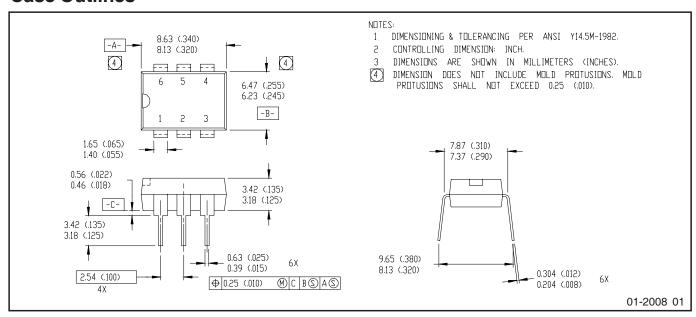
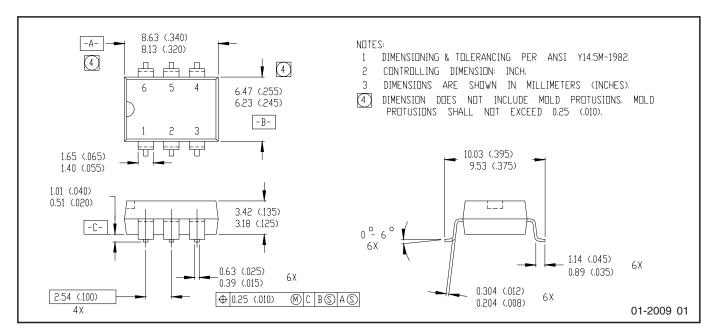


Figure 8. Delay Time Definitions



Case Outlines





Note: For the most current drawing please refer to IR website at: http://www.irf.com/package/



Qualification information[†]

Qualification level	Industrial			
Qualification level	(per JEDEC JESD47I †† guidelines)			
Majatura Canaitivity	PVG612APbF	N/A		
Moisture Sensitivity Level	PVG612ASPbF	MSL4		
Level	PVG612AS-TPbF	(per JEDEC J-STD-020E & JEDEC J-STD-033C ^{††})		
RoHS compliant		Yes		

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/product-info/reliability
- †† Applicable version of JEDEC standard at the time of product release

Revision History

Date	Comments
5/4/2015	Added Qualification Information Table on page 6
5/4/2015	Updated data sheet with new IR corporate template



IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245, USA

Data and specifications subject to change without notice

To contact International Rectifier, please visit http://www.irf.com/whoto-call/



Current Transducer HO-S series

 $I_{\rm PN}$ = 50, 100, 150, 200, 240, 250 A

Ref: HO 50-S, HO 100-S, HO 150-S, HO 200-S, HO 240-S, HO 250-S

For the electronic measurement of current: DC, AC, pulsed..., with galvanic separation between the primary and the secondary circuit.





Features

- Open loop multi-range current transducer
- Voltage output
- Single power supply +5 V
- Overcurrent detection 2.93 × I_{PN} (peak value)
- Galvanic separation between primary and secondary circuit
- Low power consumption
- · Compact design for panel mounting
- Aperture: 15 × 8 mm
- Factory calibrated
- Connection mating with JST:
 - housing PHR-5
 - contact SPH-00xT
- · Repositionable mounting foot
- Dedicated parameter settings available on request (see page 14).

Advantages

- Low offset drift
- Over-drivable U_{ref}
- 8 mm creepage /clearance
- Fast response
- Low profile 2 mm pitch connector for 24 to 32 AWG wire.

Applications

- · AC variable speed and servo motor drives
- Static converters for DC motor drives
- Battery supplied applications
- Uninterruptible Power Supplies (UPS)
- Switched Mode Power Supplies (SMPS)
- Power supplies for welding applications
- Combiner box
- MPPT.

Standards

- IEC 61800-1: 1997
- IEC 61800-2: 2015
- IEC 61800-3: 2004
- IEC 61800-5-1: 2007
- IEC 62109-1: 2010
- UL 508: 2013.

Application Domain

• Industrial.

 $N^{\circ}\ 97.K5.25.000.0;\ N^{\circ}\ 97.K5.25.030.0;\ N^{\circ}\ 97.K5.34.000.0;\ N^{\circ}\ 97.K5.34.030.0;\ N^{\circ}\ 97.K5.39.000.0;\ N^{\circ}\ 97.K5.39.030.0;\ N^{\circ}\ 97.K5.44.000.0;\ N^{\circ}\ 97.K5.44.030.0;\ N^{\circ$



Safety



If the device is used in a way that is not specified by the manufacturer, the protection provided by the device may be compromised. Always inspect the electronics unit and connecting cable before using this product and do not use it if damaged.

Mounting assembly shall guarantee the maximum primary conductor temperature, fulfill clearance and creepage distance, minimize electric and magnetic coupling, and unless otherwise specified can be mounted in any orientation.



Caution, risk of electrical shock

This transducer must be used in limited-energy secondary circuits SELV according to IEC 61010-1, in electric/electronic equipment with respect to applicable standards and safety requirements in accordance with the manufacturer's operating specifications.

Use caution during installation and use of this product; certain parts of the module can carry hazardous voltages and high currents (e.g. power supply, primary conductor).

Ignoring this warning can lead to injury and or/or cause serious damage.

De-energize all circuits and hazardous live parts before installing the product.

All installations, maintenance, servicing operations and use must be carried out by trained and qualified personnel practicing applicable safety precautions.

This transducer is a build-in device, whose hazardous live parts must be inaccessible after installation.

This transducer must be mounted in a suitable end-enclosure.

Besides make sure to have a distance of minimum 30 mm between the primary terminals of the transducer and other neighboring components.

Main supply must be able to be disconnected.

Always inspect the flexible probe for damage before using this product.

Never connect or disconnect the external power supply while the primary circuit is connected to live parts.

Never connect the output to any equipment with a common mode voltage to earth greater than 30 V.

Always wear protective clothing and gloves if hazardous live parts are present in the installation where the measurement is carried out.

This transducer is a built-in device, not intended to be cleaned with any product. Nevertheless if the user must implement cleaning or washing process, validation of the cleaning program has to be done by himself.

When defining soldering process, please use no cleaning process only.



ESD susceptibility

The product is susceptible to be damaged from an ESD event and the personnel should be grounded when handling it.

Do not dispose of this product as unsorted municipal waste. Contact a qualified recycler for disposal.



Underwriters Laboratory Inc. recognized component





Absolute maximum ratings

Parameter	Symbol	Unit	Value
Supply voltage (not destructive)	U_{C}	V	8
Supply voltage (not entering non standard modes)	U_{C}	V	6.5
Primary conductor temperature	T_{B}	°C	120
Electrostatic discharge voltage	U_{ESD}	kV	2

Stresses above these ratings may cause permanent damage. Exposure to absolute maximum ratings for extended periods may degrade reliability.

UL 508: Ratings and assumptions of certification

File # E189713 Volume: 2 Section: 5

Standards

- CSA C22.2 NO. 14-10 INDUSTRIAL CONTROL EQUIPMENT Edition 12
- UL 508 STANDARD FOR INDUSTRIAL CONTROL EQUIPMENT Edition 17

Ratings

Parameter	Symbol	Unit	Value
Primary involved potential		V AC/DC	600
Max surrounding air temperature	T_{A}	°C	105
Primary current	I_{P}	А	According to series primary current
Secondary supply voltage	U_{C}	V DC	5
Output voltage	$U_{ m out}$	V	0 to 5

Conditions of acceptability

- 1 These devices have been evaluated for overvoltage category III and for use in pollution degree 2 environment.
- 2 A suitable enclosure shall be provided in the end-use application.
- 3 The terminals have not been evaluated for field wiring.
- 5 Primary terminals shall not be straightened since assembly of housing case depends upon bending of the terminals.
- 6 Any surface of polymeric housing have not been evaluated as insulating barrier.
- 7 Low voltage control circuit shall be supplied by an isolating source (such as a transformer, optical isolator, limiting impedance or electro-mechanical relay).

Marking

Only those products bearing the UR Mark should be considered to be Listed or Recognized and covered under UL's Follow-Up Service. Always look for the Mark on the product.





Insulation coordination

Parameter	Symbol	Unit	Value	Comment
RMS voltage for AC insulation test 50/60 Hz/1 min	U_{d}	kV	4.3	
Impulse withstand voltage 1.2/50 μs	$U_{ m Ni}$	kV	8	
Partial discharge RMS test voltage (adjusted $q_{\rm m}$ < 10 pC)	U_{t}	V	1500	Busbar / Secondary, jumpers/ secondary
Clearance (pri sec.)	d_{CI}	mm	> 8	Shortest distance through air
Creepage distance (pri sec.)	d_{Cp}	mm	> 8	Shortest path along device body
Clearance (pri sec.)	-	mm	> 8	When mounted on PCB with recommended layout
Case material	-	-		V0 according to UL 94
Comparative tracking index	CTI		600	
Application example	-	V	600	Reinforced insulation according to IEC 61800-5-1, CAT III PD2
Application example	-	V	1000	Basic insulation according to IEC 61800-5-1, CAT III PD2

Environmental and mechanical characteristics

Parameter	Symbol	Unit	Min	Тур	Max	Comment
Ambient operating temperature	T_{A}	°C	-40		105	
Ambient storage temperature	T_{Ast}	°C	-40		105	
Mass	m	g		32		



HO 50 ... 250-S Electrical data HO 50-S-0100

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

A , C , L	,	, ,,	1 0 1	1 0 7		
Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	I_{PN}	А		50		
Primary current, measuring range	I_{PM}	А	-125		125	@ U _C ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{c}	V	4.5	5	5.5	
Current consumption	I_{C}	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	U_{ref}	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	$U_{\rm out} - U_{\rm ref}$	V	-2		2	Over operating temperature range
U_{ref} output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
U_{out} output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\;OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	U_{out}	mV	0		50	$U_{\rm out}$ forced to GND when EEPROM in an error state $^{2)}$
Electrical offset voltage @ $I_p = 0 \text{ A}$	U_{OE}	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	А	-0.3125		0.3125	
Temperature coefficient of U_{ref}	TCU_{ref}	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU_{OE}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of $I_{\rm OE}$	TCI _{OE}	mA/K	-4.69		4.69	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		16		800 mV @ I _{PN}
Sensitivity error @ $I_{\rm PN}$	$\varepsilon_{_{\mathrm{S}}}$	%	-0.5		0.5	Factory adjustment (straight bus-bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of I_{PN}	-0.75		0.75	
Linearity error 0 $I_{\rm PM}$	ε_{L}	% of $I_{\rm PM}$	-0.5		0.5	
Magnetic offset current (@ $10 \times I_{PN}$) referred to primary	I_{OM}	А	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/µs
Delay time @ 90 % of the final output value I_{PN} step	t _{D 90}	μs			3.5	@ 50 A/µs
Frequency bandwidth (-3 dB)	BW	kHz		100		Small signals
Noise voltage spectral density (100 Hz 100 kHz)	u_{no}	μV/√Hz			10.2	
RMS noise voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		5.6 16.3 30.6		
Primary current, detection threshold	I_{PTh}	А	2.64 × I _{PN}	2.93 × I _{PN}	3.22 × I _{PN}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\rm PN}$	ε _{s L}	% of I_{PN}	-1.25		1.25	
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +105 °C	€ _{S L 105}	% of I_{PN}	-4.80		4.80	See formula note 3)
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +85 °C	€ _{S L 85}	% of I_{PN}	-3.91		3.91	See formula note 3)

²⁾ EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases ³⁾ Sum of sensitivity and linearity error @ $T_{\rm A}$ (% of $I_{\rm PN}$) = $e_{\rm SL}$ + ($\frac{TCS}{10000}$ x ($T_{\rm A}$ -25) + $\frac{TCI_{\rm O.E.}}{10000 x I_{\rm PN}}$ x 100 x ($T_{\rm A}$ -25))



Electrical data HO 100-S-0100 HO 50 ... 250-S

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	I_{PN}	Α		100		
Primary current, measuring range	I_{PM}	Α	-250		250	@ U _c ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{c}	V	4.5	5	5.5	
Current consumption	I_{C}	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	U_{ref}	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	$U_{\rm out} - U_{\rm ref}$	V	-2		2	Over operating temperature range
$\overline{U_{\mbox{\tiny ref}}}$ output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
$\overline{U_{\mathrm{out}}}$ output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\;OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	U_{out}	mV	0		50	$U_{ m out}$ forced to GND when EEPROM in an error state $^{2)}$
Electrical offset voltage @ $I_p = 0$ A	U_{OE}	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	Α	-0.625		0.625	
Temperature coefficient of U_{ref}	$TCU_{\rm ref}$	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU_{OE}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of I_{OE}	TCI _{OE}	mA/K	-9.375		9.375	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		8		800 mV @ I _{PN}
Sensitivity error @ $I_{\rm PN}$	$\varepsilon_{_{\mathrm{S}}}$	%	-0.5		0.5	Factory adjustment (straight bus bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of $I_{\rm PN}$	-0.5		0.5	
Linearity error 0 I_{PM}	ε_{L}	% of $I_{\rm PM}$	-0.5		0.5	
Magnetic offset current (@ 10 × I_{PN}) referred to primary	I_{OM}	А	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/µs
Delay time @ 90 % of the final output value $I_{\rm PN}$ step	t _{D 90}	μs			3.5	@ 50 A/µs
Frequency bandwidth (-3 dB)	BW	μs		100		
Noise voltage spectral density (100 Hz 100 kHz)	u_{no}	μV/√Hz			6	Small signals
RMS noise voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		3.6 8.7 16.9		
Primary current, detection threshold	I_{PTh}	А	2.64 × I _{PN}	2.93 × I _{PN}	3.22 × I _{PN}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\rm PN}$	$\varepsilon_{_{\mathrm{SL}}}$	% of I_{PN}	-1		1	
Sum of sensitivity and linearity error @ I_{PN} @ T_A = +105 °C	ε _{S L 105}	% of $I_{\rm PN}$	-4.55		4.55	See formula note 3)

²⁾ EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases

³⁾ Sum of sensitivity and linearity error $@T_A(\% \text{ of } I_{PN}) = \varepsilon_{SL} + (\frac{TCS}{10000} \times (T_A - 25) + \frac{TCI_{OE}}{10000 \times I_{DN}} \times 100 \times (T_A - 25))$



Electrical data HO 150-S-0100

HO 50 ... 250-S

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	I_{PN}	Α		150		
Primary current, measuring range	I_{PM}	Α	-375		375	@ U _c ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{c}	V	4.5	5	5.5	
Current consumption	I_{C}	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	U_{ref}	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	U_{out} – U_{ref}	V	-2		2	Over operating temperature range
U_{ref} output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
$\overline{U_{\mathrm{out}}}$ output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\; OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	U_{out}	mV	0		50	$U_{\rm out}$ forced to GND when EEPROM in an error state $^{2)}$
Electrical offset voltage @ $I_P = 0$ A	$U_{\mathrm{O}\mathrm{E}}$	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	А	-0.94		0.94	
Temperature coefficient of U_{ref}	$TCU_{\rm ref}$	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU_{OE}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of I_{OE}	TCI _{o E}	mA/K	-14.1		14.1	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		5.333		800 mV @ I _{PN}
Sensitivity error @ I _{PN}	$\varepsilon_{_{\mathrm{S}}}$	%	-0.5		0.5	Factory adjustment (straight bus-bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of I_{PN}	-0.5		0.5	
Linearity error 0 I_{PM}	ε_{L}	% of I_{PM}	-0.5		0.5	
Magnetic offset current (@ 10 × I_{PN}) referred to primary	$I_{ m OM}$	Α	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/µs
Delay time @ 90 % of the final output value $I_{\rm PN}$ step	t _{D 90}	μs			3.5	@ 50 A/µs
Frequency bandwidth (-3 dB)	BW	kHz		100		Small signals
Noise voltage spectral density (100 Hz 100 kHz)	u_{no}	μV/√Hz			4.5	
RMS noise voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		2.9 6.2 12.3		
Primary current, detection threshold	I_{PTh}	Α	2.64 × I _{PN}	2.93 × I _{PN}	3.22 × I _{P N}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\rm PN}$	$\varepsilon_{\mathrm{SL}}$	% of $I_{\rm PN}$	-1		1	
Sum of sensitivity and linearity error @ $I_{\rm PN}$ @ $T_{\rm A}$ = +105 °C	€ _{S L 105}	% of $I_{\rm PN}$	-4.55		4.55	See formula note 3)
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +85 °C	ε _{S L 85}	% of $I_{\sf PN}$	-3.66		3.66	See formula note 3)

Notes: 1) 3.3 V SP version available
2) EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases
3) Sum of sensitivity and linearity error @ T_A (% of I_{PN}) = ε_{SL} + ($\frac{TCS}{10000}$ × (T_A -25) + $\frac{TCI_{OE}}{100000}$ × I_{PN} × 100 × (T_A -25))



Electrical data HO 200-S-0100

HO 50 ... 250-S

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	I_{PN}	Α		200		
Primary current, measuring range	I_{PM}	А	-500		500	@ U _c ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{c}	V	4.5	5	5.5	
Current consumption	I _C	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	$U_{ m ref}$	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	$U_{\rm out}$ – $U_{\rm ref}$	V	-2		2	Over operating temperature range
$\overline{U_{\mathrm{ref}}}$ output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
$\overline{U_{ m out}}$ output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\; OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	U_{out}	mV	0		50	$U_{\rm out}$ forced to GND when EEPROM in an error state $^{\rm 2)}$
Electrical offset voltage @ I_p = 0 A	U_{OE}	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	Α	-1.25		1.25	
Temperature coefficient of $U_{\rm ref}$	$TCU_{\rm ref}$	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU _{o E}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of I_{OE}	TCI _{OE}	mA/K	-18.75		18.75	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		4		800 mV @ I _{PN}
Sensitivity error @ I_{PN}	$\varepsilon_{_{\mathrm{S}}}$	%	-0.5		0.5	Factory adjustment (straight bus-bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of I_{PN}	-0.5		0.5	
Linearity error 0 I_{PM}	ε_{L}	% of $I_{\rm PM}$	-0.5		0.5	
Magnetic offset current (@ 10 × I_{PN}) referred to primary	I_{OM}	Α	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/µs
Delay time @ 90 % of the final output value I_{PN} step	t _{D 90}	μs			3.5	@ 50 A/µs
Frequency bandwidth (-3 dB)	BW	kHz		100		Small signals
Noise voltage spectral density (100 Hz 100 kHz)	$u_{\rm no}$	μV/√Hz			3.7	
RMS noise voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		2.5 5 10		
Primary current, detection threshold	$I_{\rm PTh}$	А	2.64 × I _{PN}	2.93 × I _{PN}	3.22 × I _{PN}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\rm PN}$	$\varepsilon_{_{\mathrm{SL}}}$	% of I_{PN}	-1		1	
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +105 °C	€ _{S L 105}	% of I_{PN}	-4.55		4.55	See formula note 3)
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +85 °C	€ _{S L 85}	% of I_{PN}	-3.66		3.66	See formula note 3)

²⁾ EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases ³⁾ Sum of sensitivity and linearity error @ T_A (% of I_{PN}) = c_{SL} + ($\frac{TCS}{10000}$ × (T_A - 25) + $\frac{TCI}{100000}$ × (T_A - 25))



Electrical data HO 240-S-0100

HO 50 ... 250-S

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	$I_{\sf PN}$	А		240		
Primary current, measuring range	I _{PM}	Α	-600		600	@ U _c ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{C}	V	4.5	5	5.5	
Current consumption	I_{C}	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	U_{ref}	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	U_{out} – U_{ref}	V	-2		2	Over operating temperature range
$\overline{U_{ m ref}}$ output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
$\overline{U_{ m out}}$ output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\;OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	U_{out}	mV	0		50	U_{out} forced to GND when EEPROM in an error state $^{\mathrm{2}}$
Electrical offset voltage @ $I_P = 0 \text{ A}$	Uoe	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	Α	-1.5		1.5	
Temperature coefficient of U_{ref}	$TCU_{\rm ref}$	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU_{OE}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of I_{OE}	TCI _{OE}	mA/K	-22.5		22.5	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		3.333		800 mV @ I _{PN}
Sensitivity error @ I _{PN}	$\varepsilon_{_{\mathrm{S}}}$	%	-0.5		0.5	Factory adjustment (straight bus-bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of $I_{\rm PN}$	-0.5		0.5	
Linearity error 0 $\dots I_{\text{PM}}$	ε_{L}	% of $I_{\rm PM}$	-0.5		0.5	
Magnetic offset current (@ 10 × I_{PN}) referred to primary	$I_{ m OM}$	Α	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/μs
Delay time @ 90 % of the final output value I_{PN} step	t _{D 90}	μs			3.5	@ 50 A/μs
Frequency bandwidth (-3 dB)	BW	kHz		100		Small signals
Noise voltage spectral density (100 Hz 100 kHz)	$u_{\rm no}$	µV/√ Hz			3.5	
RMS noise voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		2.5 5 8.7		
Primary current, detection threshold	$I_{ m PTh}$	А	2.64 × I _{P N}	2.93 × I _{PN}	3.22 × I _{PN}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\rm PN}$	$\varepsilon_{\rm SL}$	% of I_{PN}	-1		1	
Sum of sensitivity and linearity error @ I_{PN} @ T_A = +105 °C	€ _{S L 105}	% of I_{PN}	-4.55		4.55	See formula note 3)
Sum of sensitivity and linearity error @ I_{PN} @ T_A = +85 °C	€ _{S L 85}	% of I_{PN}	-3.66		3.66	See formula note 3)

²⁾ EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases

3) Sum of sensitivity and linearity error @ T_A (% of I_{PN}) = ε_{SL} + ($\frac{TCS}{10000}$ × (T_A - 25) + $\frac{TCI}{100000}$ × 100 × (T_A - 25))



Electrical data HO 250-S-0100

HO 50 ... 250-S

At $T_{\rm A}$ = 25 °C, $U_{\rm C}$ = +5 V, $R_{\rm L}$ = 10 k Ω unless otherwise noted (see Min, Max, typ. definition paragraph in page 11).

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Parameter	Symbol	Unit	Min	Тур	Max	Comment
Primary nominal RMS current	$I_{\rm PN}$	А		250		
Primary current, measuring range	I_{PM}	А	-625		625	@ U _C ≥ 4.6 V
Number of primary turns	N_{P}	-		1		See application information
Supply voltage 1)	U_{c}	V	4.5	5	5.5	
Current consumption	I_{C}	mA		19	25	
Reference voltage (output)	U_{ref}	V	2.48	2.5	2.52	Internal reference
Reference voltage (input)	U_{ref}	V	0.5		2.65	External reference
Output voltage range @ $I_{\rm PM}$	U_{out} – U_{ref}	V	-2		2	Over operating temperature range
$\overline{U_{\mathrm{ref}}}$ output resistance	$R_{\rm ref}$	Ω	130	200	300	Series
$\overline{U_{ m out}}$ output resistance	$R_{\rm out}$	Ω		2	5	Series
Load capacitance	C_{L}	nF	0		6	
OCD output on resistance	$R_{ m on\; OCD}$	Ω	70	95	150	Open drain, active low Over operating temperature range
OCD detection hold time	t _{hold OCD}	ms	0.7	1	1.4	Additional time after threshold has released
EEPROM control	$U_{ m out}$	mV	0		50	$U_{\rm out}$ forced to GND when EEPROM in an error state $^{\rm 2)}$
Electrical offset voltage @ I_p = 0 A	Uoe	mV	-5		5	$U_{\rm out}$ – $U_{\rm ref}$ @ $U_{\rm ref}$ = 2.5 V
Electrical offset current referred to primary	Ioe	А	-1.57		1.57	
Temperature coefficient of $U_{\rm ref}$	$TCU_{\rm ref}$	ppm/K	-170		170	−40 °C 105 °C
Temperature coefficient of U_{OE}	TCU_{OE}	mV/K	-0.075		0.075	−40 °C 105 °C
Temperature coefficient of $I_{\text{O E}}$	TCI _{OE}	mA/K	-23.5		23.5	−40 °C 105 °C
External detection threshold sensitivity	S_{th}	mV/A		3.2		800 mV@ I _{P N}
Sensitivity error @ I_{PN}	ε_{S}	%	-0.5		0.5	Factory adjustment (straight bus-bar)
Temperature coefficient of S	TCS	ppm/K	-350		350	−40 °C 105 °C
Linearity error 0 I_{PN}	ε_{L}	% of I_{PN}	-0.5		0.5	
Linearity error 0 I_{PM}	ε_{L}	% of $I_{\rm PM}$	-0.5		0.5	
Magnetic offset current (@ 10 × I_{PN}) referred to primary	I_{OM}	А	-0.92		0.92	One turn
Delay time to 10 % of the final output value I_{PN} step	t _{D 10}	μs			2.5	@ 50 A/μs
Delay time @ 90 % of the final output value I_{PN} step	t _{D 90}	μs			3.5	@ 50 A/µs
Frequency bandwidth (-3 dB)	BW	kHz		100		Small signals
Noise voltage spectral density (100 Hz 100 kHz)	$u_{\rm no}$	μV/√ Hz			3.5	
RMS voltage (DC 10 kHz) (DC 100 kHz) (DC 1 MHz)	U_{no}	mVpp		2.5 5 8.7		
Primary current, detection threshold	$I_{\rm PTh}$	А	2.64 × I _{PN}	2.93 × I _{PN}	3.22 × I _{PN}	Peak value ±10 %, overcurrent detection OCD
Sum of sensitivity and linearity error @ $I_{\scriptscriptstyle \mathrm{PN}}$	$\varepsilon_{_{\mathrm{SL}}}$	% of I_{PN}	-1		1	
Sum of sensitivity and linearity error @ $I_{\rm PN}$ @ $T_{\rm A}$ = +105 °C	€ _{S L 105}	% of I_{PN}	-4.55		4.55	See formula note 3)
Sum of sensitivity and linearity error @ I_{PN} @ T_{A} = +85 °C	€ _{S L 85}	% of I_{PN}	-3.66		3.66	See formula note 3)

²⁾ EEPROM in an error state makes the transducer behave like a reverse current saturation. Use of the OCD may help to differentiate the two cases ³⁾ Sum of sensitivity and linearity error @ T_A (% of I_{PN}) = ε_{SL} + ($\frac{TCS}{10000}$ × (T_A - 25) + $\frac{TCI_{OE}}{10000 \times I_{PN}}$ × 100 × (T_A - 25))





Definition of typical, minimum and maximum values

Minimum and maximum values for specified limiting and safety conditions have to be understood as such as well as values shown in "typical" graphs.

On the other hand, measured values are part of a statistical distribution that can be specified by an interval with upper and lower limits and a probability for measured values to lie within this interval.

Unless otherwise stated (e.g. "100 % tested"), the LEM definition for such intervals designated with "min" and "max" is that the probability for values of samples to lie in this interval is 99.73 %.

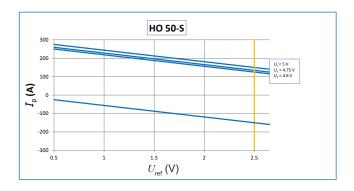
For a normal (Gaussian) distribution, this corresponds to an interval between -3 sigma and +3 sigma. If "typical" values are not obviously mean or average values, those values are defined to delimit intervals with a probability of 68.27 %, corresponding to an interval between -sigma and +sigma for a normal distribution.

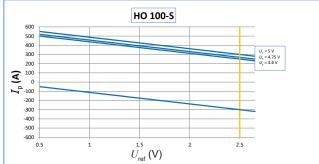
Typical, maximal and minimal values are determined during the initial characterization of the product.

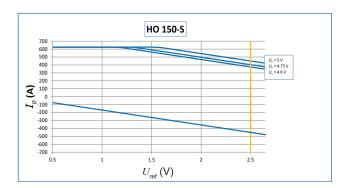


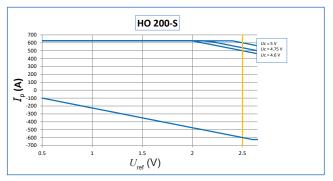


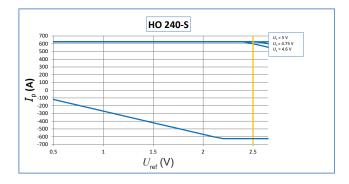
HO-S series, measuring range versus external reference voltage

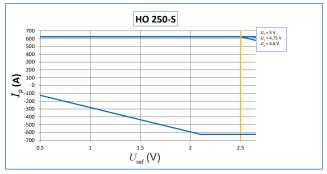








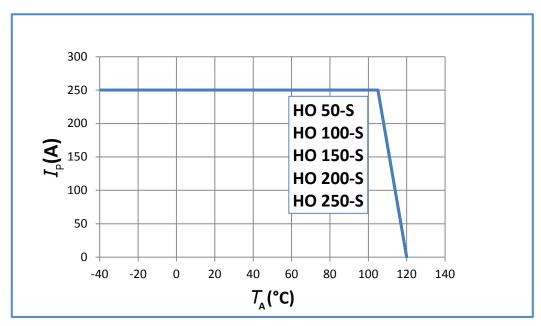






Maximum continuous DC current

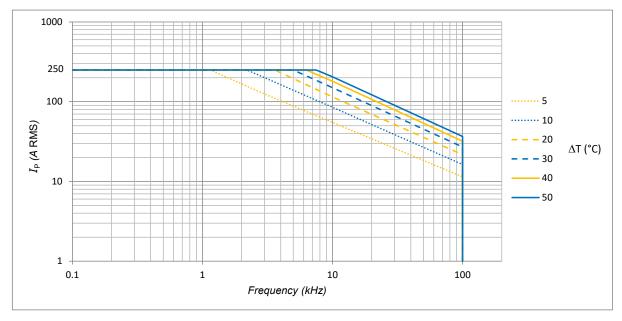
For all ranges:



Important notice: whatever the usage and/or application, the transducer primary bar temperature shall not go above the maximum rating of 120 °C as stated in page 3 of this datasheet.

Frequency derating versus primary current and core temperature increase ΔT (°C)

Primary current in A RMS is sine wave.



Example:

Primary current ripple (sine wave): 50 A RMS

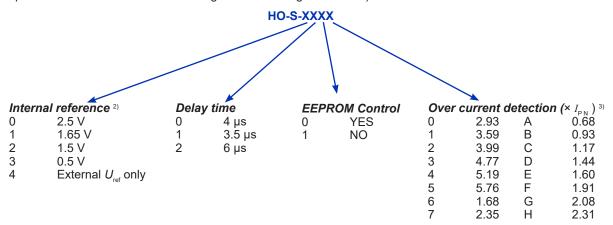
Ripple frequency: 20 kHz

- the core temperature increase is 10 °C



HO-S series: name and codification

HO family products may be ordered **on request** ¹⁾ with a dedicated setting of the parameters as described below (standard products are delivered with the setting 0100 according to the table).



Standard products: HO 50-S-0100; HO 100-S-0100; HO 100-S-3110; HO 150-S-0100; HO 200-S-0100; HO 200-S-0107; HO 240-S-0100; HO 250-S-0100; HO 250-S-010D

Notes: 1) For dedicated settings, minimum quantities apply, please contact your local LEM support.

 $^{\rm 2)}$ $U_{\rm ref}$ electrical data

		$U_{ m ref}$ (V)	TCU_{ref} (ppm/K)	
U_{ref} parameter	min	typ	max	min	max
0	2.48	2.5	2.52	-170	-70
1	1.63	1.65	1.67	-170	170
2	1.48	1.5	1.52	-170	170
3	0.49	0.5	0.51	-250	250

 $^{^{3)}}$ OCD (× $I_{\rm P\,N}$) correction table versus range and temperature All other values or empty cells: no change

	HO-S-010x						
OCD	I_{PN} (A) all temperatures						
Parameter	150	200	240	250			
Α							
В							
С							
D							
E							
6							
F							
G							
Н							
7							
0							
1							
2							
3			510	5.60			
4			6.70	7.30			
5		6.25		_			

Tolerance on OCD value					
±20 %					
±15 %					
±10 %	No change				
-	Do not use				





Application information

- HOxx-S series is designed to be used with a bus-bar or a cable ¹⁾ to carry the current through the aperture with a maximum cross-section of 8 × 15 mm
- Use of a bare conductor is not recommended with panel mounting (either horizontal or vertical) as insulation distances might be compromised between the busbar and fixation screws.

Insulation distance (nominal values):

	$d_{ extsf{Cp}}$	d_{CI}
Between primary busbar and secondary pin	14.6 mm	-
Between primary busbar and core	-	11.34 mm
Between core and secondary terminal	-	1.18 mm

Note: 1) The maximum magnetic offset referred to primary is inversely proportional to the number of turns, thus is divided by 2 with 2 turns

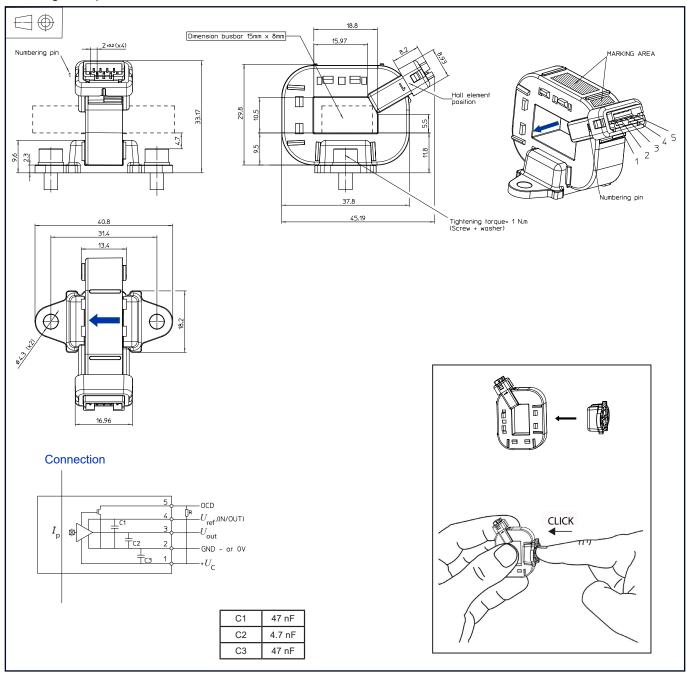
Remark

Installation of the transducer must be done unless otherwise specified on the datasheet, according to LEM Transducer Generic Mounting Rules. Please refer to LEM document N°ANE120504 available on our Web site: https://www.lem.com/en/file/3137/download/.



Dimensions HO-S series (mm, general linear tolerance ±0.3 mm)

Mounting example: horizontal



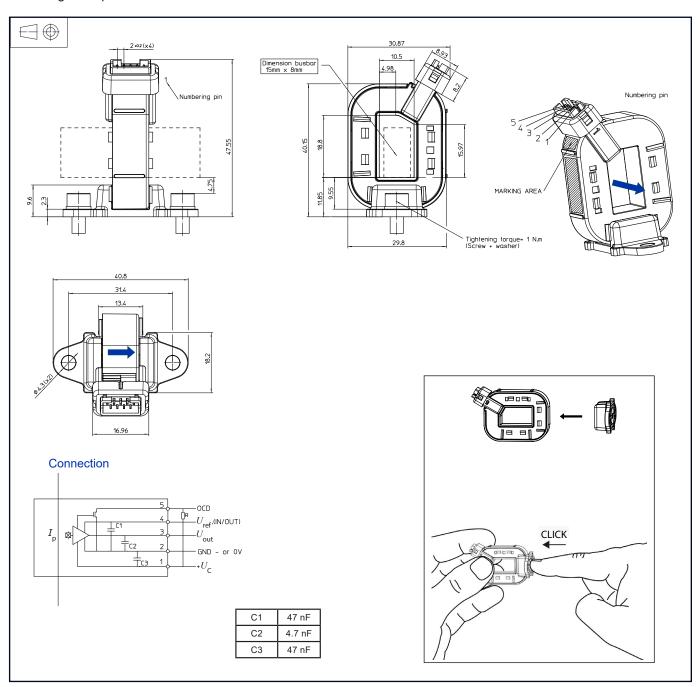
Remarks:

- ullet $U_{ ext{out}}$ is positive with respect to $U_{ ext{ref}}$ when positive $I_{ ext{p}}$ flows in direction of the arrow shown on the drawing above
- Connection system: equivalent to JST B5B-PH type
- Mounting foot may be removed and repositioned as shown on pages 16,17 and 18 of this datasheet. We recommend to change the mounting foot position just once.



Dimensions HO-S series (mm, general linear tolerance ±0.3 mm)

Mounting example: vertical



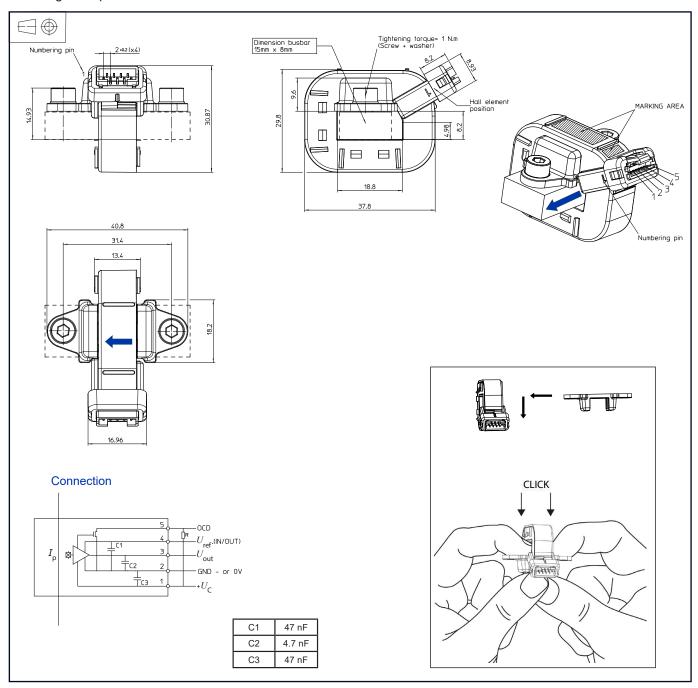
Remarks:

- U_{out} is positive with respect to U_{ref} when positive I_{p} flows in direction of the arrow shown on the drawing above.
- Connection system: equivalent to JST B5B-PH type
- Mounting foot may be removed and repositioned as shown on pages 16,17 and 18 of this datasheet.
 We recommend to change the mounting foot position just once.



Dimensions HO-S series (mm, general linear tolerance ±0.3 mm)

Mounting example: busbar



Remarks:

- ullet $U_{
 m out}$ is positive with respect to $U_{
 m ref}$ when positive $I_{
 m P}$ flows in direction of the arrow shown on the drawing above
- Connection system: equivalent to JST B5B-PH type
- Mounting foot may be removed and repositioned as shown on pages 16,17 and 18 of this datasheet.
 We recommend to change the mounting foot position just once.



Customer Specification

PART NO. 6711

Construction

	Diameters (In)	
1) Component 1	1 X 1 HOOKUP	
a) Conductor	26 (7/34) AWG Tinned Copper	0.019
b) Insulation	0.0095" Wall, Nom. MPPE	0.038+/- 0.002
(1) Color(s)	WHITE, BLACK, RED, GREEN, YELLOW, BLUE, BROWN ORANGE, SLATE, VIOLET, GREEN/YELLOW, PINK BLACK/WHITE, GREEN/WHITE, BLUE/WHITE, WHITE/GREEN WHITE/BROWN, WHITE/RED, WHITE/BLUE, WHITE/VOILET YELLOW/WHITE, DARK BLUE, WHITE/ORANGE WHITE/SLATE, RED/BLACK, WHITE/YELLOW	

Applicable Specifications

1) UL	AWM/STYLE 11028	105°C / 600 V _{RMS}
	VW-1	
2) CSA International	C(RU) AWM I A/B FT1	105°C / 600 V _{RMS}
3) Other	Halogen-Free	
	IEC 60332-2 Flame Behavior	
4) CE:	EU Low Voltage Directive 2014/35/EU	
	,	

Environmental

1) EU Directive 2011/65/EU(RoHS2), EU Directive 2015/863/EU (RoHS3):	
	All materials used in the manufacture of this part are in compliance with European Directive 2011/65/EU and the amending Directive 2015/863/EU of 4 June 2015 regarding the restriction of use of certain hazardous substances in electrical and electronic equipment.
2) REACH Regulation (EC 1907/2006):	
	This product does not contain Substances of Very High Concern (SVHC) listed on the European Union's REACH candidate list in excess of 0.1% mass of the item.

Properties

-40 to 105°C 5X Cable Diameter 2.18 Lbs, Maximum	
2.18 Lbs, Maximum	
(For Engineering purposes only)	
600 V _{RMS}	
0.06 μH/ft, Nominal	
41 Ω/1000ft @20°C, Nominal	
6	

Other

Packaging	Flange x Traverse x Barrel (inches)
a) 25000 DR	23 x 20 x 0 Max. 2 separate pieces; Min length/piece 5000 FT.
b) 5000 FT	9 x 4.5 x 3.5 Continuous length
c) 1000 FT	6.5 x 3 x 3.25 Continuous length
d) 100 FT	3.75 x 2 x 1.75 Continuous length
	[Spool dimensions may vary slightly]
Notes:	
a) The following colors are availible by special order only: PINK, BLACK/WHITE, GREEN/WHITE, BLUE/WHITE, WHITE/GREEN, WHITE/BROWN, WHITE/RED, WHITE/BLUE, WHITE/VOILET, YELLOW/WHITE, WHITE/ORANGE, WHITE/SLATE, RED/BLACK, WHITE/YELLOW.	

www.alphawire.com

Alpha Wire 2200 US Highway 27 South Richmond, IN 47374

Tel: 1-800-52 ALPHA

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EU/UK/China ROHS CERTIFICATE OF COMPLIANCE

To Whom It May Concern:

Alpha Wire Part Number: 6711

6711, RoHS-Compliant Commencing With 7/1/2009 Production

Note: all colors and put-ups

This document certifies that the Alpha part number cited above, including all packaging materials, is manufactured in accordance with Directive 2011/65/EU of the European Parliament, better known as the RoHS Directive (commonly known as RoHS 2), with regards to restrictions of the use of certain hazardous substances used in the manufacture of electrical and electronic equipment. This certification extends to amending Directive 2015/863/EU which expanded the list of restricted substances to 10 items (commonly known as RoHS 3). This product also complies with UK - RoHS. The reader is referred to these Directives for the specific definitions and extents of the Directives. **No Exemptions are required for RoHS Compliance on this item**. Additionally, Alpha certifies that the listed part number is in compliance with China RoHS "Marking for Control of Pollution by Electronic Information Products" standard SJ/T 11364-2014. This product is also in compliance with China RoHS 2 per GB/T 26572-2011.

Substance	Maximum Control Value
Lead	0.1% by weight (1000 ppm)
Mercury	0.1% by weight (1000 ppm)
Cadmium	0.01% by weight (100 ppm)
Hexavalent Chromium	0.1% by weight (1000 ppm)
Polybrominated Biphenyls (PBB)	0.1% by weight (1000 ppm)
Polybrominated Diphenyl Ethers (PBDE),	
Including Deca-BDE	0.1% by weight (1000 ppm)
Bis(2-ethylhexyl) phthalate (DEHP)	0.1% by weight (1000 ppm)
Butyl benzyl phthalate (BBP)	0.1% by weight (1000 ppm)
Dibutyl phthalate (DBP)	0.1% by weight (1000 ppm)
Diisobutyl phthalate (DIBP)	0.1% by weight (1000 ppm)

The information provided in this document and disclosure is correct to the best of Alpha Wire's knowledge, information and belief at the date of its release. The information provided is designed only as a general guide for the safe handling, storage, and any other operation of the product itself or the one that it will become part of. The intent of this document is not to be considered a warranty or quality specification. Regulatory information is for guidance purposes only. Product users are responsible for determining the applicability of legislation and regulations based on their individual usage of the product.

Authorized Signatory for the Alpha Wire:

Dave Watson, Director of Engineering 6/9/2025

Alpha Wire 2200 US Highway 27 South Richmond, IN 47374 Tel: 1-908-925-8000

1249500 DATA SHEET

valid from: 15.03.2022

ÖLFLEX® HEAT 180 SiF A



Application

ÖLFLEX® HEAT SiF A are UL/cRU certified, heat resistant silicone single cores for the European and North American market, for fixed installation under low mechanical stress. They are halogen-free and feature low toxicity of gases and corrosivity in case of fire. They are characterized by good ozone and UV resistances and suitable for use under high ambient temperatures provided adequate ventilation.

Application range:

Control cabinets, wiring and connecting in devices and apparatus engineering, heating elements, air-conditioning, sauna and solaria construction as well as in other operating ranges.

Use acc. to UL: Internal wiring of appliances where totally enclosed.

Use acc. to cRU: CSA AWM I A/B, internal wiring of equipment with or without mechanical abuse.

Design

Certification

Design based on EN 50525-2-41

acc. to UL 758, Style 3644 CSA AWM C22.2 No. 210-15 UL AWM Style 3644, UL 758

cRU AWM I A/B, C22.2 No. 210-15

Conductor fine wire strands of non-porous tinned copper acc. to IEC 60228 resp. EN 60228, class 5

Insulation Silicone compound acc. to UL 1581, table 50.210 (150°C) and El2 acc. to EN 50363-1

Core identification code Available core colours:

GN-YE / BK / BN / BU / GY / WH / OG / GN / YE / VT / RD / DBU

Electrical properties at 20 °C

Nominal voltage U_0/U : 600/1000 V

UL/cRU: 1000 V

Test voltage 3000 V AC

Mechanical and thermal properties

Minimum bending radius fixed installation: 6 x outer diameter

One bend at end of core: 3 x outer diameter

Temperature range fixed installation: (UL/CSA) up to +150°C

(EN) -50°C up to +180°C (adequate ventilation required)

Flammability flame retardant acc. to IEC 60332-1-2 resp. EN 60332-1-2

UL: Horizontal Flame Test

Halogen free acc. to IEC 60754-1 resp. EN 60754-1
Corrosivity of gases acc. to IEC 60754-2 resp. EN 60754-2

Toxicity acc. to EN 50305

UV resistance acc. to EN ISO 4892-2, method A (change of color allowed)

Ozone resistance acc. to EN 50396, method B

General requirements

These cables are conform to the EU-Directive 2014/35/EU (Low Voltage Directive)

Environmental information These cables meet the substance-specific requirements of the EU Directive 2011/65/EU (RoHS).

Creator: LABU / PDC Document: DB1249500EN

Released: ALTE / PDC Version: 04

Page 1 of 1

|--|

Datasheet

Product Name:UL11028 26AWGProduct Discription:UL11028 26AWGSpecification No.:SPEC-UL11028-26AWGCustomer's Name:Customer's Name:

Conductor Size(AWG)
Construction(±0.008mm)
Stranded Dia.(mm)Ref.
Insulation Material
Insulation Color
Ave Thickness(mm)
Min Thickness(mm)
Insulation Dia.(±0.05mm)
Remark:
8724458 Black
E254881A AWM STYLE 11028 26AWG 105°C 600V VW-1
CA AWM I A 105°C 600V FT1 -LFHF- ELETECK 8724464 Blue
Test Material
Before
Aging
After
Approved by Date Aging
Deformation(121±1℃*250g)
Cold Bend(-10±1℃*4hrs)
Heat Shock(121±1℃*1hr)
Max.DC Resistance(20℃ Ω/km)
Flammability Test

RS, Professionally Approved Products, gives you professional quality parts across all products categories. Our range has been testified by engineers as giving comparable quality to that of the leading brands without paying a premium price.



Technical data sheet

Article number: 308-30300

HIS-3-3/1



Product Group	Heat shrinkable tubing 3:1 on a reel
Product Family	HIS-3
Material	Polyolefin, cross-linked (PO-X)
Colour	Black (BK)
Behaviour at Heat Shock	not fluid, not dripping, not cracking
Behaviour at Low Temperature [Test method]	not cracking [UL 224]
Dielectric Strength [Test method]	32 kV/mm [IEC 60243]
Elongation at break [Test method]	800 [ASTM D2671]
Elongation At Heat Aging	400 %
Flammability	UL 224 VW-1
Heat Aging Test [Test method]	168h/175°C [UL 224]
Heat Shock Test	4h/250°C
Insulation Class	B (VDE 0530)
Longitudinal Change After Shrinkage	+/-5%
Min. Shrink Temperature - °C	+100 °C
Minimum Tensile Strength At Heat Aging	13 MPa
Operating Temperature	-55 °C to +135 °C
Package Content packed in	pcs.
Pack Cont.	10 m
Recov. Ø d max.	1.0 mm
Shrink Ratio	3:1
Specifications	ANSI/UL 224, C22.2 no. 198.1-06
Supplied Ø D min.	3.2 mm
Tensile Strength [Test method]	14 MPa [ASTM D2671]
UL-File Number	E143529
Wall (WT)	0.55 mm





Technical data sheet

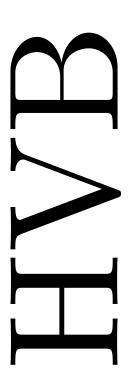
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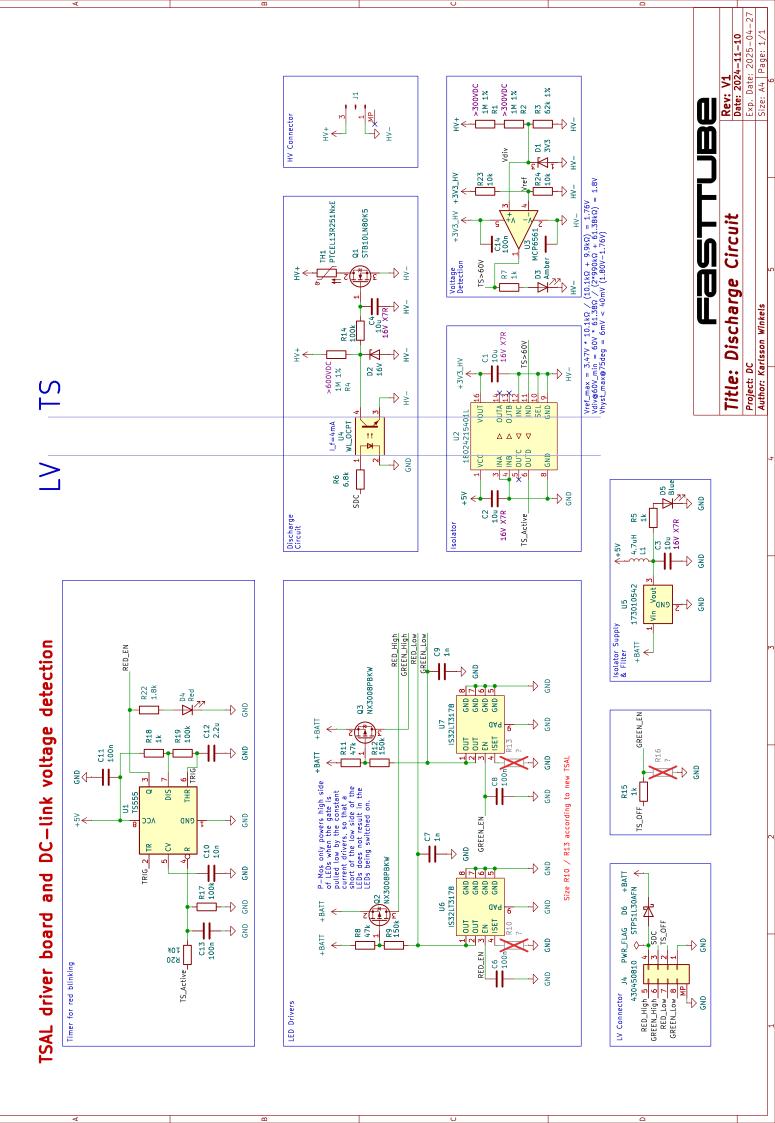
HIS-3-12/4

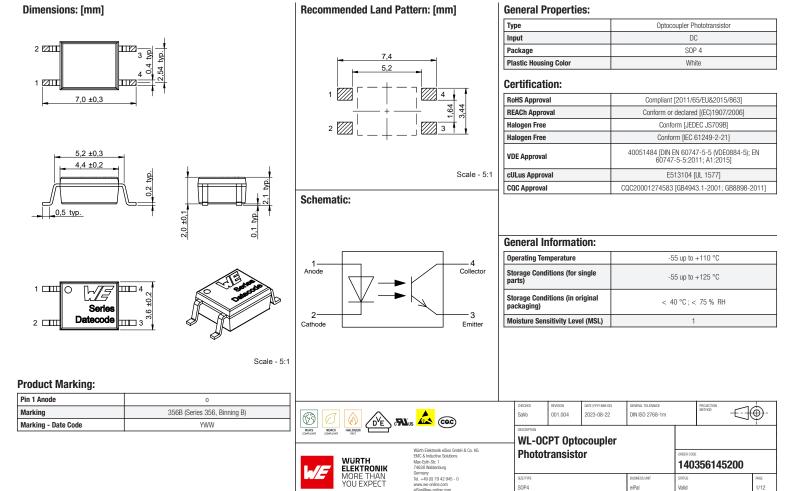


Product Group	Heat shrinkable tubing 3:1 on a reel
Product Family	HIS-3
Material	Polyolefin, cross-linked (PO-X)
Colour	Black (BK)
Behaviour at Heat Shock	not fluid, not dripping, not cracking
Behaviour at Low Temperature [Test method]	not cracking [UL 224]
Dielectric Strength [Test method]	32 kV/mm [IEC 60243]
Elongation at break [Test method]	800 [ASTM D2671]
Elongation At Heat Aging	400 %
Flammability	UL 224 VW-1
Heat Aging Test [Test method]	168h/175°C [UL 224]
Heat Shock Test	4h/250°C
Insulation Class	B (VDE 0530)
Longitudinal Change After Shrinkage	+/-5%
Min. Shrink Temperature - °C	+100 °C
Minimum Tensile Strength At Heat Aging	13 MPa
Operating Temperature	-55 °C to +135 °C
Package Content packed in	pcs.
Pack Cont.	5 m
Recov. Ø d max.	4.0 mm
Shrink Ratio	3:1
Specifications	ANSI/UL 224, C22.2 no. 198.1-06
Supplied Ø D min.	12.7 mm
Tensile Strength [Test method]	14 MPa [ASTM D2671]
UL-File Number	E143529
Wall (WT)	0.80 mm









dard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Würth Elekt principles of the production of the p

Absolute Maximum Ratings Input Properties (Ambient Temperature 25 $^{\circ}\text{C}$ unless otherwise specified):

Properties		Test conditions	Value	Unit
Forward Current	I _{F max.}		60	mA
Peak Forward Current	I _{F Peak}	duty/ 100 @ 100 Hz	1	Α
Input Power Dissipation	P _I		100	mW
Reverse Voltage	V _{REV}		6	٧

Absolute Maximum Ratings Output Properties: (Ambient Temperature 25 $^{\circ}\text{C}$ unless otherwise specified):

Properties		Value	Unit
Collector Emitter Voltage	V _{CE}	80	V
Emitter Collector Voltage	V _{EC}	7	٧
Collector Current	I _{CE.P}	50	mA
Output Power Dissipation	Po	150	mW

Absolute Maximum Ratings Common Properties:

Properties		Test conditions	Value	Unit
Power Dissipation 1)	P _{Diss}		200	mW
Isolation Voltage	V _{ISO}	AC for 1 Minute, RH 40~60 %	3750	V (RMS)

¹⁾ Total power dissipation of the whole component

Electrical & Optical Input Properties:

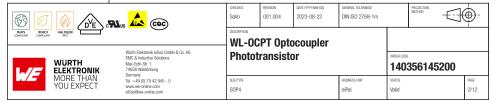
Dronartica	Test conditions	Value			
Properties		lest conditions	typ.	max.	Unit
Forward Voltage	V _F	I _F = 10 mA	1.24	1.4	V
Reverse Current	I _{REV}	V _{REV} = 6 V		10	μА
Input Capactiance	C _{in}	V = 0 V f = 1 kHz	10		pF

Electrical & Optical Output Properties:

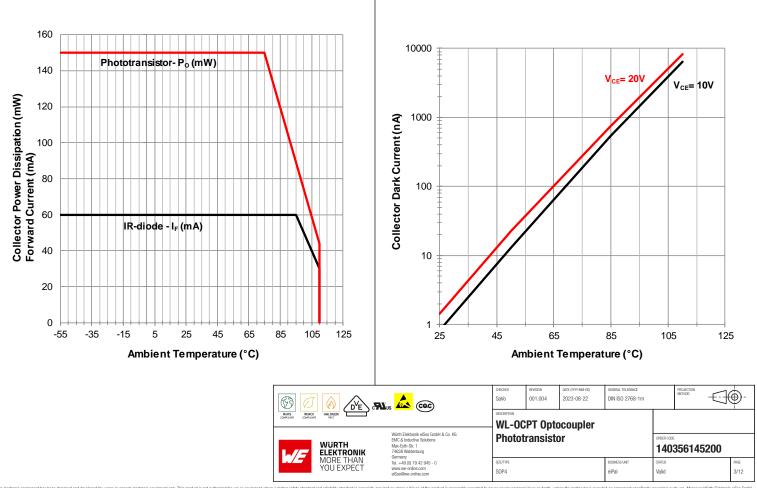
Properties		Test conditions	Value		
Fioperues	perties	rest conditions	min.	max.	Unit
Collector-Emitter Dark Current	I _{CEO.Dark}	V _{CE} = 20 V I _F = 0		100	nA
Collector-Emitter Breakdown Voltage	V _{(BR)CE}	$I_{C} = 100 \ \mu A$ $I_{F} = 0$	80		V
Emitter-Collector Breakdown Voltage	V _{(BR)EC}	$I_E = 100 \mu\text{A}$ $I_F = 0$	7		V

Electrical & Optical Transfer Properties:

	T	Value			
	lest conditions	min.	typ.	max.	Unit
CTR	$I_{\text{F}} = 5 \text{ mA}$ $V_{\text{CE}} = 5 \text{ V}$	130		260	%
V _{CEsat}	I _F = 20 mA I _C = 1 mA		0.06	0.2	V
t _r	$\begin{array}{l} V_{CE} = 2 \text{ V} \\ I_C = 2 \text{ mA} \\ R_L = 100 \Omega \end{array}$		3	18	μs
t _f	$\begin{array}{l} V_{CE} = 2 \text{ V} \\ I_{C} = 2 \text{ mA} \\ R_{L} = 100 \Omega \end{array}$		4	18	μs
f _c	$\begin{array}{l} V_{CE}=2~V\\ I_{C}=2~mA\\ R_{I}=100~\Omega\\ -3~dB \end{array}$		80		kHz
C _{IO}	V = 0 V f = 1 MHz		0.4		pF
R _{ISO}	DC = 500 V 40~60 % R.H.	1	100		ΤΩ
	V _{CEsat} t _r t _f f _c C _{IO}	$\begin{array}{lll} V_{CEsat} & I_{F} = 20 \text{ mA} \\ I_{C} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} t_{T} & I_{CE} = 2 \text{ V} \\ I_{CE} = 2 \text{ mA} \\ R_{L} = 100 \Omega \end{array}$ $\begin{array}{lll} t_{T} & I_{CE} = 2 \text{ V} \\ I_{CE} = 2 \text{ mA} \\ R_{L} = 100 \Omega \end{array}$ $\begin{array}{lll} V_{CE} = 2 \text{ V} \\ I_{CE} = 2 \text{ mA} \\ R_{L} = 100 \Omega \end{array}$ $\begin{array}{lll} V_{CE} = 2 \text{ V} \\ I_{CE} = 2 \text{ mA} \\ I_{CE} = 100 \Omega \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$ $\begin{array}{lll} I_{CE} = 1 \text{ mA} \\ I_{CE} = 1 \text{ mA} \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$



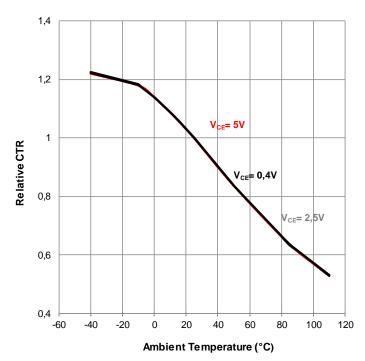
This described component has been designed and developed for usage in precent electronic component has been designed and developed for usage in precent electronic resultance of the product in example and precent precent preceding and precent preceding and preceding an



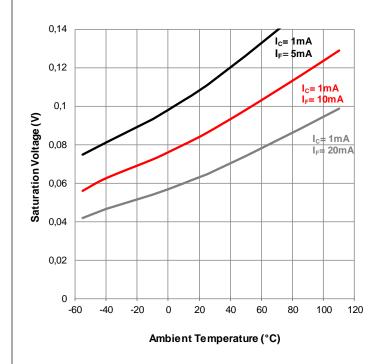
Collector Dark Current vs. Ambient Temperature:

Total Power Dissipation vs. Ambient Temperature:

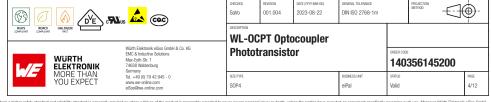
Relative CTR vs. Ambient Temperature:

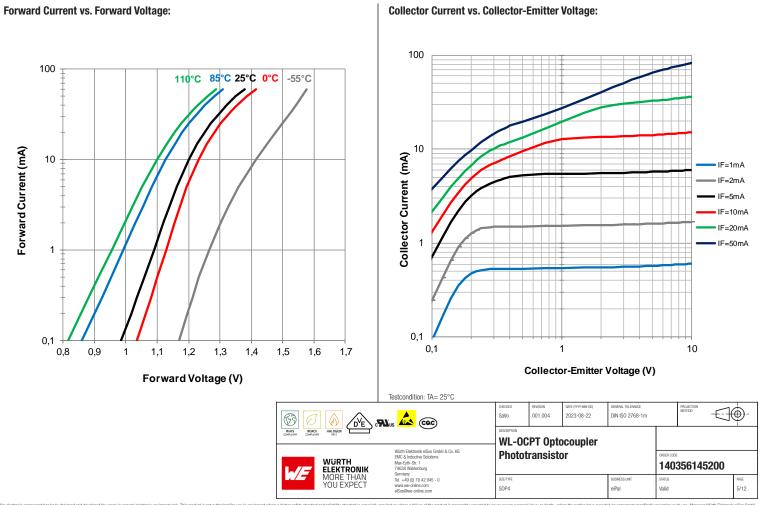


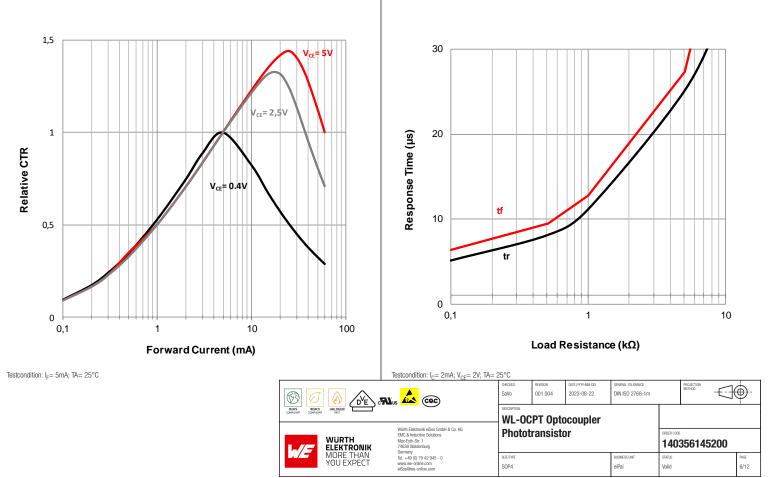
Collector-Emitter Saturation Voltage vs. Ambient Temperature:



Testcondition: IF= 5mA; Normalized to TA= 25°C



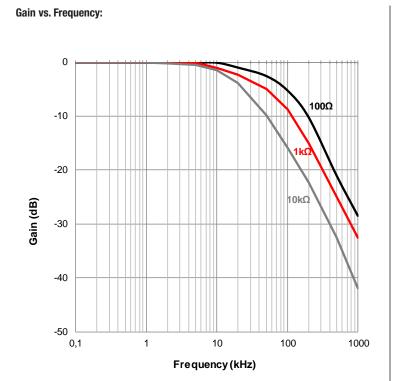




Switching time vs. Load Resistance:

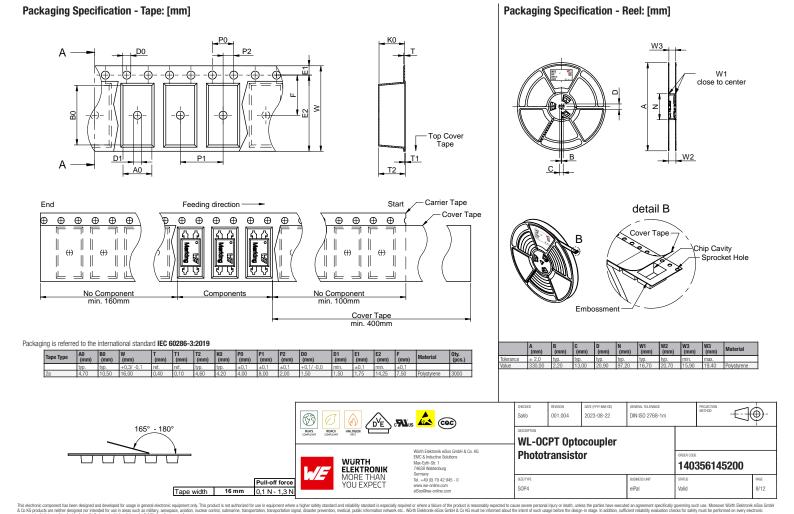
Relative CTR vs. Forward Current:

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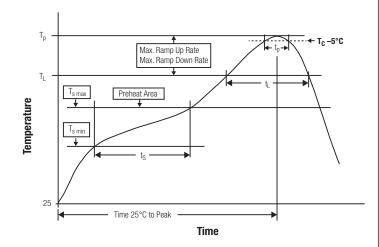


Testcondition: I_{C} = 2mA; V_{CE} = 2V; TA= 25°C

WITH Elektronic kellos Griefel & Co. NG Electronic component has been designed and developed for usage in general electronic corporent has been designed and developed for usage in general electronic corporent has been designed and developed for usage in general electronic corporent has been designed and developed for usage in general electronic corporent has been designed and developed for usage in general electronic corporent has been designed and developed for usage in general electronic corporance shape and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance thas been designed and developed for usage in general electronic corporance to the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties and the parties have exceeded an agreement specifically governing such use. Moreover With Elektronic elsos for the parties and the



Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

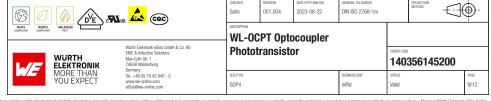
Profile Feature		Value
Preheat Temperature Min	T _{s min}	150 °C
Preheat Temperature Max	T _{s max}	200 °C
Preheat Time t_s from T_{smin} to T_{smax}	t _s	max. 60 - 120 seconds
Ramp-up Rate (T _L to T _P)		3 °C/ second max.
Liquidous Temperature	T _L	217 °C
Time t _L maintained above T _L	t _L	max. 60 seconds
Peak package body temperature	T _p	$T_p \le T_c$, see Table below
Time within 5°C of actual peak temperature	t _p	max. 10 seconds
Ramp-down Rate (T _P to T _L)		6 °C/ second max.
Time 25°C to peak temperature		max. 220 seconds

refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature (T_c):

Properties	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000	
PB-Free Assembly Package Thickness < 1.6 mm	260 °C	260 °C	260 °C	
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C	
PB-Free Assembly Package Thickness > 2.5 mm	250 °C	245 °C	245 °C	
Applied cycles	2 cycles max.			

refer to IPC/ JEDEC J-STD-020E



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Cautions and Warnings:

The following conditions apply to all goods within the product series of Optoelectronic Components of Würth Elektronik eiSos GmbH & Co. KG:

General:

- This ontoelectronic component is designed and manufactured for use in general electronic equipment
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control ship control), transportation signal, disaster prevention, medical, public information network, etc. where higher safety and reliability are especially required and/or if there is the possibility of direct damage or human injury.
- Optoelectronic components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer. The optoelectronic component is designed and manufactured to be used within the datasheet specified values. If the usage and

- operation conditions specified in the datasheet are not met, the wire insulation may be damaged or dissolved.

 Do not drop or impact the components, the component may be damaged

 Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth Elektronik does not warrant any customer qualified product characteristics beyond Würth Elektroniks' specifications, for its validity and sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products also apply to customer specific products.

 Unless Würth Elektrolk has given its express consent, the customer is under no circumstances entitled to reverse engineer, disassemble
- or otherwise attempt to extract knowledge or design information from the optoelectronic component.

Product specific:

Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- All other soldering methods are at the customers' own risk
 The soldering pad pattern shown above is a general recommendation for the easy assembly of optoelectronic components. If a high degree of precision is required for the selected application (i.e. high density assembly), the customer must ensure that the soldering pad pattern is optimized accordingly.

Cleaning and Washing:

Washing agents used during the production to clean the customer application might damage or change the characteristics of the optoelectronic component body, marking or plating. Washing agents may have a negative effect on the long-term functionality of the

Using a brush during the cleaning process may break the optoelectronic component body. Therefore, we do not recommend using a brush during the PCB cleaning process.

Potting:

If the product is potted in the customer application, the potting material might shrink or expand during and after hardening. Shrinking could lead to an incomplete seal, allowing contaminants into the optoelectronic component body, pins or termination. Expansion could damage the components. We recommend a manual inspection after potting to avoid these effe

Storage Conditions:

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
- Do not expose the optoelectronic component to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2. For a moisture sensitive component, the storage condition in the original packaging is defined according to IPC/JEDEC-J-STD-033. It is also recommended to return the optoelectronic component to the original moisture proof bag and reseal the moisture proof bag again.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

Packaging:

The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

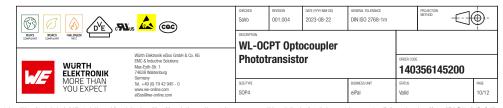
Handling:

- Violation of the technical product specifications such as exceeding the nominal rated current, will void the warranty.
- The product design may influence the automatic optical inspection
- Certain optoelectronic component surfaces consist of soft material. Pressure on the top surface has to be handled carefully to prevent negative influence to the function and reliability of the optoelectronic components.

 ESD prevention methods need to be applied for manual handling and processing by machinery.
- Resistors for protection are obligatory.
- In addition to optoelectronic components testing, products incorporating these devices have to comply with the safety precautions given in IEC 60825-1, IEC 62471 and IEC 62778

Technical specification:

The typical and/or calculated values and graphics of technical parameters can only reflect statistical figures. The actual parameters of each single product, may differ from the typical and/or calculated values or the typical characteristic line.



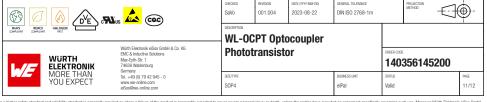
oilly standard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Winth Elektronic eScs Gmith & Co KG must be informed about the intent of such usage before the design-in stage, in addition, sufficient reliability evaluation checks for safety must be performed on ever

- In the characteristics curves, all values given in dotted lines may show a higher deviation than the paramters mentioned above.
- On each rela, only one bin is sorted and taped. The bin is defined on the current transfer ratio.

 In order to ensure highest availability, the reel binning of standard deliveries can vary. A single bin cannot be ordered. Please contact us in advance, if you need a particular bin sorting before placing your order.

 These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

The customer has the sole responsibility to ensure that he uses the latest version of this datasheet, which is available on Würth Elektronik's homepage. Unless otherwise agreed in writing (i.e. customer specific specification), changes to the content of this datasheet may occur without notice, provided that the changes do not have a significant effect on the usability of the optoelectronic components.



oilly standard is especially required or where a failure of the product is reasonably expected to cause severe personal injury or death, unless the parties have executed an agreement specifically governing such use. Moreover Worth Elektronik elSos Grobt A Co KG must be informed about the intent of such usage before the design-in stage. In addition, sufficient reliability evaluation checks for safety must be performed on every electronic

Important Notes

The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a suitability for or suitability for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

6. Product Life Cycle

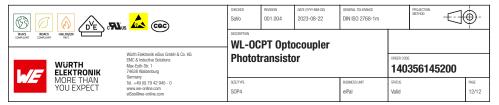
Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.



This electronic component has been designed and developed for usage in general electronic equipment only. This product is not authorized for use in equipment where a higher safety standard and reliability standard is especially required or where a tailure of the product is reasonably expected to cause severe personal injury or death, unless the parties have excuted an agreement specifically governing such use. Moreover Winth Elektronic Risks GnibH & Co Kill must be informed about the intent of such usage before the design-in stage, in addition, sufficient reliability evaluation checks for safety must be performed on every electronic component which is a consistent of except the parties that require this safety or electronic and the parties of the parties that require this safety or electronic and the parties that require this safety or electronic and the parties of the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that required this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties that require this safety or electronic and the parties of the parties that require this safety and the parties t



www.vishay.com

Vishay BCcomponents

PTC Thermistors, Inrush Current Limiter





LINKS TO ADDITIONAL RESOURCES







QUICK REFERENCE DATA				
PARAMETER (1)	VALUE	UNIT		
Resistance at 25 °C (R ₂₅) (2)	60 to 1000	Ω		
Switching temperature	130 to 140	°C		
Maximum inrush current	10 to 40	Α		
Maximum AC voltage (2)	350 to 800	V _{RMS}		
Maximum DC voltage (2)	500 to 1200	V_{DC}		
Maximum peak voltage (3)	4000	V_P		
Maximum energy at 25 °C (1)	150 to 240	J		
Operating temperature range	-40 to 105	°C		
Storage temperature range	-55 to 165	°C		
Dissipation factor	14.5 to 19.5	mW/K		
Thermal time constant (τ_c) (still air cooling)	130 to 155	s		
Weight	3.5 to 5.7	g		

Notes

- (1) Definitions, measurements, and tests are made in accordance with standard IEC 60738-1 "Thermistors - Directly heated positive temperature coefficient" and AEC-Q200 stress test qualification for passive components
- (2) Other resistance values and maximum operating voltages available on request.
 - Matched resistance values available on request
- Maximum peak voltages are based on 8/20 µs pulses that can be applied with limited none-switching energy

AGENCY APPROVALS

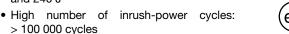
Agency approval documents, please see:

www.vishay.com/ppg?29165&documents

UL recognition standard for safety is UL 1434: "Thermistor-Type Devices". UL file E148885

FEATURES

• High energy absorption levels up to 150 J and 240 J





RoHS

- Highly resistant against non-switching peak-powers of up to 25 kW
- Can handle high direct voltage up to 1200 V
- · Self protecting in case of overload with no risk of over-heating
- AEC-Q200 qualified
- C-UL-US recognized under file E148885 for AC and DC use
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

Inrush current limiting and load-dump resistor in:

- AC/DC and DC/DC converters
- · Load dump and DC-Link circuits
- · Emergency discharge circuits
- · OBC, battery charging equipment
- Motor drives
- Welding equipment

PTCEL thermistors have resistance values that can change instantly based on the applied voltage levels and varying body temperatures.

DESCRIPTION

These directly heated ceramic-based doped barium titanate thermistors have a positive temperature coefficient and are primarily intended for inrush current limiting and overload protection. They consist of a ceramic pellet soldered between two tinned CCS wires and coated with a UL 94 V-0 compliant high temperature silicone lacquer. The body is marked with the logo, cold resistance value, EL on one side and date code on the opposite side.

MOUNTING

Important mounting and handling instructions, see:

www.vishay.com/doc?29223

By soldering in any position.

Not intended for potting or sealing.

Maximum surface temperature in case of overload can reach 200 °C.

PACKAGING

PTC thermistors are available in 200 pieces individually packed in layered PET trays or tape on reel 500 pieces.



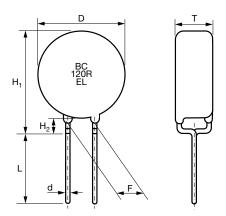
www.vishay.com

Vishay BCcomponents

ELECTRICAL DA	TA A	ND ORD	ERING	INFORM	IATION						
PART NUMBER (1)	R ₂₅ (Ω)	R ₂₅ TOL. (%)	V _{MAX.} (V _{RMS})	V _{LINK MAX} .	R _{MIN.} < 1.5 V _{DC} (Ω)	J _{HOLD} AT 25°C (mA)	C _{th} (J/K)	E _{MAX.} 1 CYCLE AT 25°C (J)	τ _{th} (s)	LEAD PITCH F (mm)	UL RECOG. C TU'US
PTCEL13R600LxE	60	30	350	500	32	120	1.45	150	130	5.0	✓
PTCEL13R121MxE	120	30	440	625	64	85	1.45	150	130	5.0	✓
PTCEL13R251NxE	250	30	480	680	130	60	1.45	150	130	5.0	✓
PTCEL13R501RxE	500	30	560	800	260	42	1.45	150	130	5.0	√
PTCEL13R102SxE	1000	30	600	850	520	30	1.45	140	130	5.0	✓
PTCEL17R600MxE	60	30	440	625	32	140	2.3	240	155	5.0	√
PTCEL17R600MxE303	60	30	440	625	32	140	2.3	240	155	7.5	✓
PTCEL17R121NxE	120	30	460	650	64	100	2.3	240	155	5.0	√
PTCEL17R251SxE	250	30	600	850	130	70	2.3	240	155	5.0	✓
PTCEL17R501TxE	500	30	700	1000	260	50	2.3	230	155	5.0	✓
PTCEL17R501TxE302	500	30	700	1000	260	50	2.3	230	155	7.5	✓
PTCEL17R501TxE401	500	30	700	1000	260	50	2.3	230	155	10.0	✓
PTCEL17R102UxE404	1000	30	800	1200	500	35	2.3	230	155	10.0	

Note

OUTLINE AND DIMENSIONS



COMPONENT DIMENSIONS in millimeters							
SYMBOL	PTC	EL13		PTCEL17			
D	13.5	max.		16.5 max.			
d	0.6 ±	0.6 ± 0.05		0.8 ± 0.05			
H ₁	17 r	nax.	20 max.				
H ₂	3 :	± 1		3 ± 1			
Т	7.0 i	7.0 max. 7.5 max.					
F ⁽¹⁾	5.0 ± 0.8	7.5 ± 0.8	5.0 ± 0.8	7.5 ± 0.8	10.0 ± 0.8		
L (2)	20 min.	18 min.	20 min.	18 min.	16 min.		

Notes

⁽¹⁾ Replace the x by B for bulk or T for tape and reel

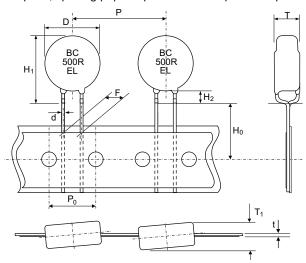
⁽¹⁾ F pitch = see "Electrical Data and Ordering Information" table for available wire pitch part numbers

 $[\]stackrel{\text{\tiny (2)}}{\text{\tiny L}}$ lead length corresponds to available wire pitch part numbers

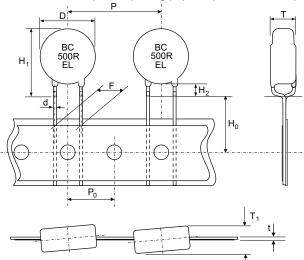


TAPE AND REEL DIMENSIONS

Taping on reel with F = 5.0 mm wire pitch, spacing paper tape and foam separator tape used on reel.



Taping on reel with F = 7.5 mm and 10.0 mm wire pitch, spacing paper tape and foam separator tape used on reel.



SYMBOL	PARAMETER	VALUE
D	Body diameter	See bulk dimensions
d	Lead diameter	See bulk dimensions
Р	Component pitch	25.4 ± 1.0
P ₀	Feedhole pitch	12.7 ± 0.3
F	Lead center to lead center distance (between component and tape)	
	13R and 17R type *TE (leads between feedholes)	5.0 +0.5/-0.2
	13R and 17R type *TE3xx (feedhole between leads)	7.5 +0.5/-0.2
	17R type *TE4xx (feedhole between leads)	10.0 +0.5/-0.2
H ₀	Lead wire clinch height	16.0 ± 0.5
H ₂	Component bottom to seating plane	3.0 ± 1.0
H ₁	Component top to seating plane	See bulk dimensions
Т	Body thickness	See bulk dimensions
t	Total tape thickness	1.7 max.
T ₁	Total thickness	T + 1.0 max.

REQUIRED NUMBER OF PTC THERMISTORS TO LIMIT CURRENT AND ABSORB ENERGY

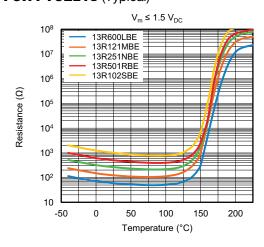
By using several PTC's in a series / parallel network, the maximum current limitation and absorbed energy levels can be further optimized. For homogeneous current and energy distribution it is recommended to combine only PTCEL of the same size and matched resistance value. Energy absorption per PTC in a network depends on current distribution in the network and as such on the individual PTC resistance value. PTCEL thermistors might be used in a series connection to further lower the inrush current, but not to increase the maximum allowed voltage levels. Following formula may be used to calculate the minimum number of PTCEL thermistors of the same size and matched resistance value that are required in a DC link or other capacitor bank application to properly charge or discharge a given amount of non-repetitive energy without follow current. The formula is valid for one charge or discharge operation within cool down period of at least 5 times the thermal time constant and for which the T_{PTC} equals the T_{amb} before a consecutive operation.

$$N \ge \frac{K \times C \times V^2}{2 \times C_{th} \times (T_{sw} - T_{amb})}$$
Notes

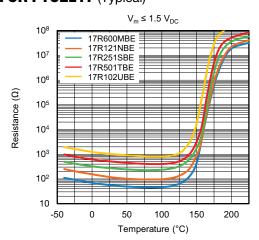
Notes

- N is the number of PTCEL required in the network
- C is the total capacitor value to charge or discharge in F
- V is the maximum DC voltage on the capacitor C
- C_{th} is the thermal capacity of one PTC in [J/K] (see table)
- T_{sw} is the minimum switching temperature of the PTCEL (130 °C)
- T_{amb} is the maximum ambient temperature at which the PTC needs to operate
- K is the factor that determines the charging operation mode
 - K = 1 for DC charging or discharging
 - K = 0.96 for 3-phase rectified charging
 - K = 0.76 for single phase rectified charging

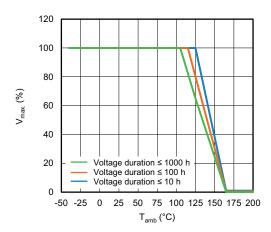
RESISTANCE VS. TEMPERATURE FOR PTCEL13 (Typical)



RESISTANCE VS. TEMPERATURE FOR PTCEL17 (Typical)



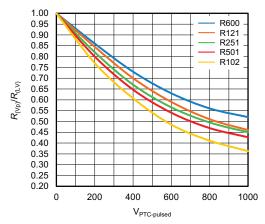
V_{max.} DERATING VS. T_{amb}

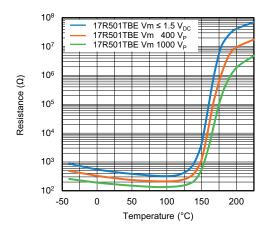




PTC RESISTANCE UNDER PULSED VOLTAGE

RESISTANCE VS. TEMPERATURE PULSED (Typical)

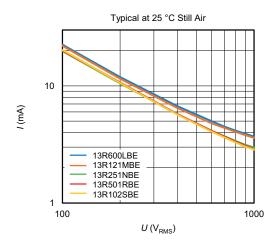




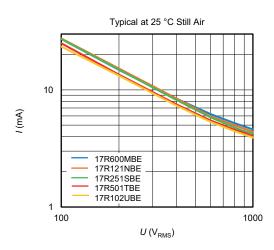
Notes

- The minimum PTC resistance values under (pulsed) voltage are depending on actual minimum resistance value in the temperature range of 70 °C to 100 °C. The actual voltage dependency effect or R_(Vp)/R_(LV) ratio of ceramic PTC is depending on its resistance values at low voltage (R_(LV)). The different curves represent the influence of (pulsed) voltage related to the PTCEL value types in the minimum resistance temperature range of 70 °C to 100 °C. A PTC resistance value R_(LV) can be taken from the "Resistance vs Temperature" graphs and multiplied by a corresponding ratio to estimate the (minimum) resistance value and determine a maximum peak current at a defined voltage. Example: a PTCEL17R501TBE type has a R_{min.} (see Electrical Data table) of 260 Ω at around 90 °C, and at a 1000 V peak-voltage the resistance will drop to 260 Ω x 0.43 (red curve) = 112 Ω, which will give rise to a peak-current of around 9 Ap. Actual peak currents that could be reached at certain voltage levels can be more precisely evaluated by using the available SPICE models
- Also check the graph "Resistance vs. Temperature Pulsed" to see the typical resistance to voltage dependency effect on a PTCEL17R501TBE

RESIDUAL CURRENT VS. VOLTAGE FOR PTCEL13

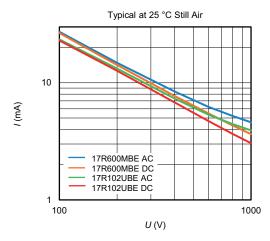


RESIDUAL CURRENT VS. VOLTAGE FOR PTCEL17

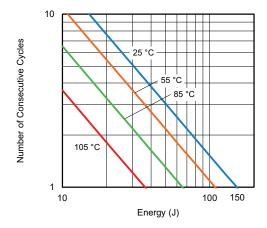




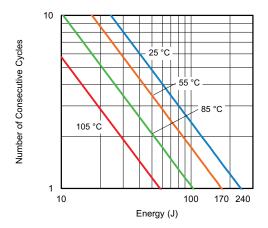
RESIDUAL CURRENT VS. VOLTAGE AC / DC



CONSECUTIVE ENERGY AT DIFFERENT T_{amb} FOR PTCEL13



CONSECUTIVE ENERGY AT DIFFERENT T_{amb} FOR PTCEL17



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N-channel 800 V, 0.55 Ω typ., 8 A MDmesh™ K5 Power MOSFET in a D²PAK package

Datasheet - production data

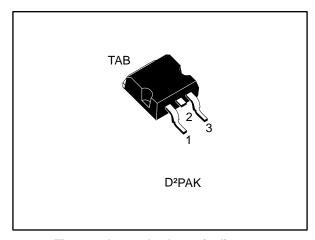
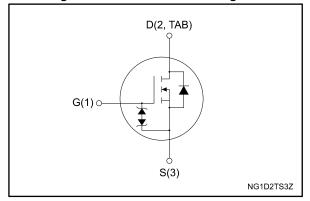


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STB10LN80K5	800 V	0.63 Ω	8 A

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code Marking		Package	Packing	
STB10LN80K5	10LN80K5	D ² PAK	Tape and reel	

Contents STB10LN80K5

Contents

1	Electric	al ratings	3
2	Electric	cal characteristics	4
	2.2	Electrical characteristics (curves)	6
3	Test cir	cuits	9
4	Packag	e information	10
	4.1	D2PAK package information	10
	4.2	Packing information	13
5	Revisio	n history	15

STB10LN80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 30	V
I_D	Drain current (continuous) at T _C = 25 °C	8	Α
I _D	Drain current (continuous) at T _C = 100 °C	5	Α
I _D ⁽¹⁾	Drain current (pulsed)	32	Α
P _{TOT}	Total dissipation at T _C = 25 °C	110	W
dv/dt (2)	Peak diode recovery voltage slope	4.5) //
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T _j	Operating junction temperature range	FF to 150	°C
T _{stg}	Storage temperature range	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.14	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	35	°C/W

Notes

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{\text{jmax}})$	2.7	Α
E _{AS}	Single pulse avalanche energy (starting Tj = 25 ° C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	240	mJ

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 8$ A, di/dt \leq 100 A/ μ s; V_{DS} peak < V(BR)DSS

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $[\]ensuremath{^{(1)}}\xspace$ When mounted on FR-4 board of 1 inch² , 2 oz Cu

Electrical characteristics STB10LN80K5

2 Electrical characteristics

 T_C = 25 ° C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 ^{\circ}\text{C}$			50	μA
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 10	μΑ
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 4 \text{ A}$		0.55	0.63	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	427	-	pF
C _{oss}	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	43	-	pF
C _{rss}	Reverse transfer capacitance	VG3 - 0 V	-	0.25	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$	-	72	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V		27	-	pF
R_g	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	7	-	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 8 \text{ A}$	-	15	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	4.2	-	nC
Q_{gd}	Gate-drain charge	See Figure 16: "Test circuit for gate charge behavior"	-	9	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_{D} = 4 A, R_{G} = 4.7 Ω	ı	11.8	-	ns
t _r	Rise time	V _{GS} = 10 V	ı	10	-	ns
$t_{d(off)}$	Turn-off delay time	See Figure 15: "Test circuit for resistive load switching times"	-	28	-	ns
t _f	Fall time	and Figure 20: "Switching time waveform"	-	13	-	ns



 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS}

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		8	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		1		32	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 8 \text{ A}, V_{GS} = 0 \text{ V}$	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 8 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	350		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$	-	3.9		μC
I _{RRM}	Reverse recovery current	See Figure 17: "Test circuit for inductive load switching and diode recovery times"	,	22.5		А
t _{rr}	Reverse recovery time	$I_{SD} = 8 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,}$	-	505		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	5		μC
I _{RRM}	Reverse recovery current	See Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	20		Α

Notes:

Table 9: Gate-source Zener diode

Symbol Parameter		Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} = 0 A	30	,	1	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

⁽¹⁾Pulse width limited by safe operating area

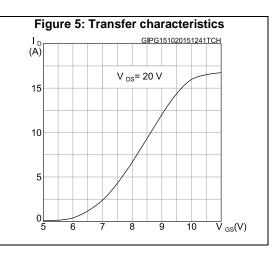
 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 μ s, duty cycle 1.5%

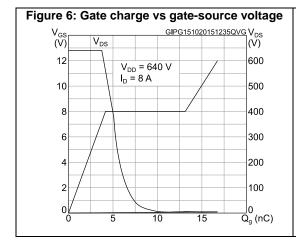
2.2 Electrical characteristics (curves)

Figure 3: Thermal impedance $\begin{array}{c} K \\ \delta = 0.5 \\ \hline \delta = 0.2 \\ \hline \delta = 0.1 \\ \hline \delta = 0.1 \\ \hline \delta = 0.02 \\ \hline \delta = 0.05 \\ \hline \delta = 0.05 \\ \hline \delta = 0.02 \\ \hline \delta = 0.01 \\ \hline SINGLE PULSE \\ \hline \\ 10^{-2} \\ \hline 10^{-5} \\ \hline 10^{-4} \\ \hline 10^{-3} \\ \hline 10^{-2} \\ \hline 10^{-1} \\ \hline t_p |_{\overline{T}} \\ \hline \\ 5 |_{\phi}(s) \\ \hline \end{array}$

Figure 4: Output characteristics

| Comparison of the comparison o





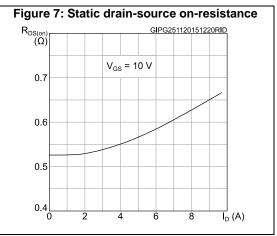


Figure 8: Capacitance variations

C (pF)

103

102

101

10-1

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Figure 9: Normalized gate threshold voltage vs temperature

V_{GS(th)}
(norm.)

1.2

1.0

0.8

0.6

0.4

0.2

-50

0

50

100

T_j(°C)

Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG151020151154RON

(norm.)

2.6

V_{GS} = 10 V

2.2

1.8

1.4

1.0

0.6

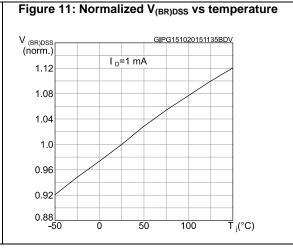
0.2

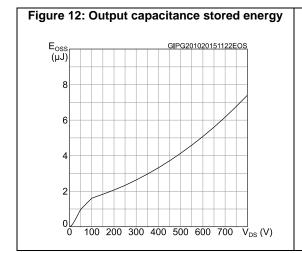
-50

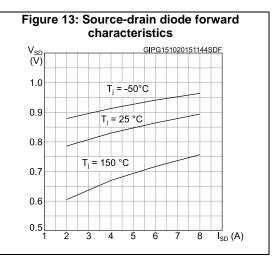
0 50

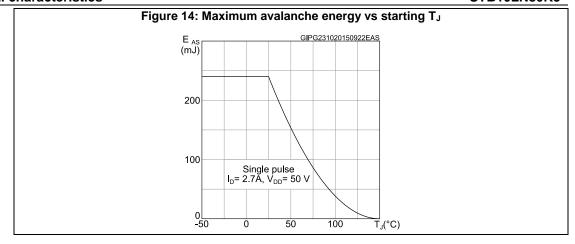
100

T_j (°C)









STB10LN80K5 Test circuits

3 Test circuits

Figure 15: Test circuit for resistive load switching times

Figure 16: Test circuit for gate charge behavior

12 V 47 kΩ 100 nF 1 kΩ

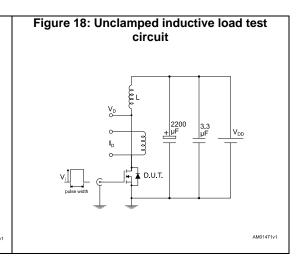
Vos 1 kΩ 1 kΩ

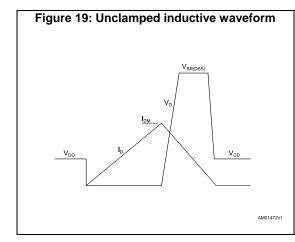
Vos 1 kΩ 1 kΩ

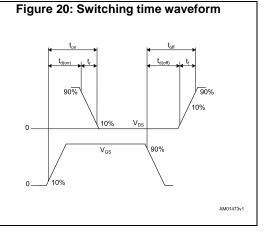
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Figure 17: Test circuit for inductive load switching and diode recovery times

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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

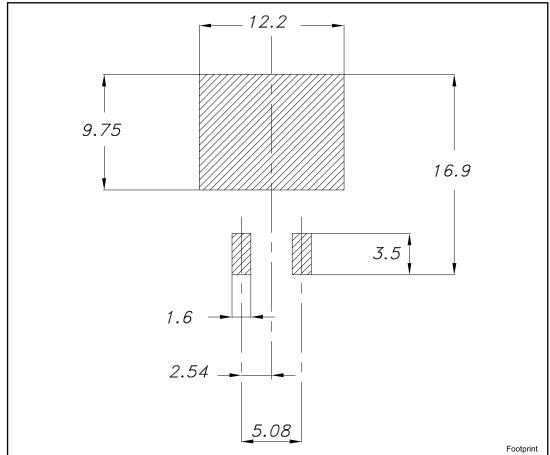
4.1 D²PAK package information

Figure 21: D²PAK (TO-263) type A package outline E1 c2-L1 THERMAL PAD SEATING PLANE COPLANARITY A 1 0.25 GAUGE PLANE V2_ 0079457_A_rev22

Table 10: D²PAK (TO-263) type A package mechanical data

	mm				
Dim.	Min.	Тур.	Max.		
А	4.40		4.60		
A1	0.03		0.23		
b	0.70		0.93		
b2	1.14		1.70		
С	0.45		0.60		
c2	1.23		1.36		
D	8.95		9.35		
D1	7.50	7.75	8.00		
D2	1.10	1.30	1.50		
Е	10		10.40		
E1	8.50	8.70	8.90		
E2	6.85	7.05	7.25		
е		2.54			
e1	4.88		5.28		
Н	15		15.85		
J1	2.49		2.69		
L	2.29		2.79		
L1	1.27		1.40		
L2	1.30		1.75		
R		0.4			
V2	0°		8°		





4.2 Packing information

Figure 23: Tape outline

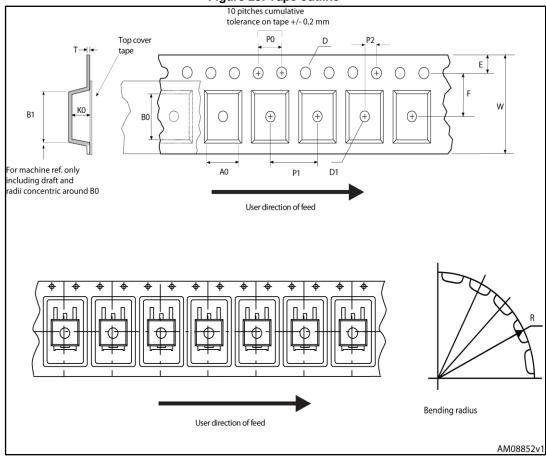


Figure 24: Reel outline

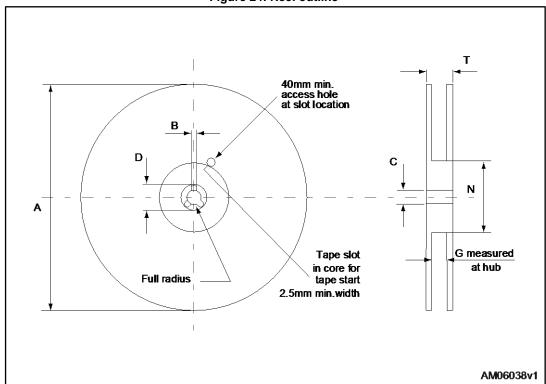


Table 11: D2PAK tape and reel mechanical data

	Таре				
Dim.	m	nm	Dim.	m	ım
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	А		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D 20.2		
Е	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base q	uantity	1000
P2	1.9	2.1	Bulk quantity		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

STB10LN80K5 Revision history

5 Revision history

Table 12: Document revision history

Date	Revision	Changes
04-May-2015	1	First release.
08-Feb-2016	2	Modified: Table 2: "Absolute maximum ratings", Table 3: "Thermal data", Table 4: "Avalanche characteristics", Table 5: "On/off-state", Table 7: "Switching times" and Table 8: "Source-drain diode" Added: Section 3.1: "Electrical characteristics (curves)" Datasheet promoted from preliminary data to production data Minor text changes

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10-TO-200MA CONSTANT-CURRENT LED DRIVER FOR AUTOMOTIVE

June 2024

GENERAL DESCRIPTION

The IS32LT3177 and IS32LT3178 are adjustable linear current devices with excellent temperature stability. A single resistor is all that is required to set the operating current from 10mA to 200mA. The devices can operate from an input voltage from 2.9V to 40V with a minimal voltage headroom of 1.0V (Typ.) at 150mA. Designed with a low dropout voltage; the device can drive LED strings close to the supply voltage without switch capacitors or inductors.

The IS32LT3177/78 simplifies designs by providing a stable current without the additional requirement of inductors, FETs or diodes. The complete constant current driver requires only a current set resistor and a small PCB area making designs both efficient and cost effective.

The EN Pin of the IS32LT3177 can be tied to V_{BAT} or PSM (Power Supply Modulation) signal for high side dimming. The EN Pin of the IS32LT3178 can function as the PWM signal input used for MCU PWM dimming.

As a current sink it is ideal for LED lighting applications or current limiter for power supplies.

The device is provided in a lead (Pb) free, SOT23-6 and SOP-8-EP packages.

FEATURES

- Low-side current sink
 - Adjustable from 10mA to 150mA (SOT23-6)/200mA (SOP-8-EP) with external resistor selection
- · Wide input voltage range from
 - 2.9V to 40V (IS32LT3178)
 - 5V to 40V (IS32LT3177)
 - with a low dropout of typical 1.0V at 150mA
- Up to 1kHz PWM input (IS32LT3178 only)
- Protection features:
 - 0.6%/K current roll off at high temp over 145°C for thermal protection
 - Output current limit
 - Thermal shutdown
- Up to 0.77W (SOT23-6)/2.32W (SOP-8-EP) power dissipation in a small package
- RoHS & Halogen-Free Compliance
- TSCA Compliance
- AEC-Q100 Qualified with Temperature Grade 1: -40°C to 125°C

APPLICATIONS

- Automotive and avionic lighting
- Stop/tail light
- Turn light
- Retail lighting in fridge, freezer case and vending machines



TYPICAL APPLICATION CIRCUIT

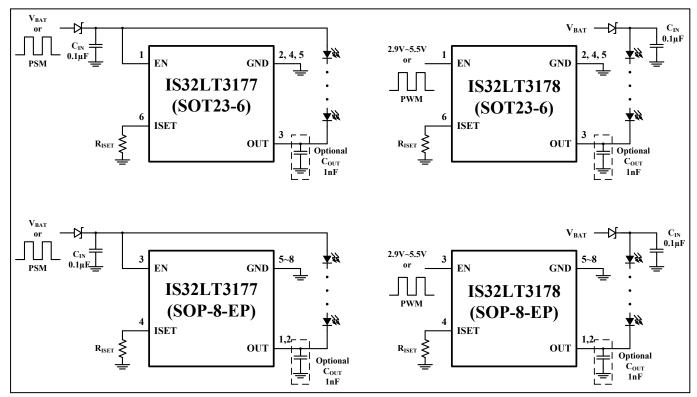


Figure 1 Typical Application Circuit

- Note 1: All GND pins must be connected to ground.
- Note 2: C_{IN} must be placed close to IC. If no PSM dimming requirement, please use larger value for C_{IN}.
- Note 3: Cout is optional. When the LED connection wire is long, the Cout should be placed close to OUT pin to avoid EMI interference.
- Note 4: RISET MUST be placed close to ISET and GND pins to improve the Electro-Magnetic Susceptibility (EMS) performance.



PIN CONFIGURATION

Package	Pin Configuration (Top View)
SOT23-6	EN
SOP-8-EP	OUT

PIN DESCRIPTION

No.		Dim	Description			
SOT23-6 SOP-8-EP		Pin	Description			
3	1, 2	OUT	Current sink.			
1	3	EN	Enable pin (PWM input IS32LT3178 only).			
6	4	ISET	Output current setting pin. Connect a resistor between this pin and GND to set the maximum output current.			
2, 4, 5	5~8	GND	Ground pin. All GND pins must be connected to supply ground.			
-		Thermal Pad	Connect to GND.			



ORDERING INFORMATION

Automotive Range: -40°C to +125°C

Order Part No.	Package	QTY/Reel
IS32LT3177-STLA3-TR IS32LT3178-STLA3-TR	SOT23-6, Lead-free	3000
IS32LT3177-GRLA3-TR IS32LT3178-GRLA3-TR	SOP-8-EP, Lead-free	2500

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- a.) the risk of injury or damage has been minimized;
- b.) the user assume all such risks; and
- c.) potential liability of Lumissil Microsystems is adequately protected under the circumstances



ABSOLUTE MAXIMUM RATINGS (Note 5)

Maximum enable voltage, V _{EN(MAX)} only for IS32LT3177	44V
	1
V _{EN(MAX)} only for IS32LT3178	6.0V
Maximum output current, Iout(MAX)	250mA
Maximum output voltage, V _{OUT(MAX)}	44V
Reverse voltage between all terminals, V _R	0.5V
Power dissipation, P _{D(MAX)} (Note 6)	0.77W (SOT23-6)
Power dissipation, PD(MAX) (Note 6)	2.32W (SOP-8-EP)
Maximum junction temperature, T _{JMAX}	+150°C
Storage temperature range, T _{STG}	-65°C ~ +150°C
Operating temperature range, T _A =T _J	-40°C ~ +125°C
Package thermal resistance, junction to ambient (4-layer standard test PCB	130°C/W (SOT23-6)
based on JESD 51-2A), θ _{JA}	43.1°C/W (SOP-8-ÉP)
Package thermal resistance, junction to thermal PAD (4-layer standard test	1 11°C/M (COD 0 ED)
PCB based on JESD 51-8), θ _{JP}	1.41°C/W (SOP-8-EP)
ESD (HBM)	±2kV
ESD (CDM)	±750V

Note 5: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 6: Detail information please refer to package thermal de-rating curve on Page 16.

ELECTRICAL CHARACTERISTICS

- "●" This symbol in the table means these parameters are for IS32LT3177.
- "o" This symbol in the table means these parameters are for IS32LT3178.
- "♦" This symbol in the table means these limits are guaranteed at room temp T_J= 25°C.
- "♦" This symbol in the table means these limits are guaranteed at full temp range T_J= -40°C~ +125°C.

Test condition is T_J= -40°C~+125°C, unless otherwise specified. (Note 7)

Symbol	Parameter	Condition			Min.	Тур.	Max.	Unit
V_{BD_OUT}	OUT pin breakdown voltage	V _{EN} = 0V			40			V
	Chable assessed	V _{EN} = 12V, R _{ISET} =16kΩ		•		0.5	1.00	Л
I _{EN}	Enable current	V _{EN} = 3.3V, R _{ISET} =16kΩ		0		0.5	1.00	mA
VISET	Current setting reference voltage					1.0		٧
		V _{OUT} = 0.8V, V _{EN} = 12V,		•		10		
	R _{ISET} = 160kΩ	•	\(\)		10		A	
		V_{OUT} = 0.8V, V_{EN} = 3.3V, R_{ISET} = 160k Ω		•		10		- mA
			0	\(\)		10		
		VOUT> 1.0V. VEN= 3.3V.		•	97	100	103	
I	Output current		•	\(\)	95	100	105	
l _{OUT}	Voi			•	97	100	103	
		R_{ISET} = 16k Ω , SOP-8-EP	0	\Diamond	95	100	105	mΛ
		V _{OUT} > 1.0V, V _{EN} = 12V,		•	96.5	100	103.5	mA
		R _{ISET} = $16k\Omega$, SOT23-6	•	\(\)	94	100	106	
		V _{OUT} > 1.0V, V _{EN} = 3.3V,		•	96.5	100	103.5	
		R _{ISET} = $16k\Omega$, SOT23-6	0	\Q	94	100	106	



ELECTRICAL CHARACTERISTICS (CONTINUE)

Symbol	Parameter	Condition			Min.	Тур.	Max.	Unit				
	V _{OUT} > 1.5V, V _E			*	145.5	150	154.5					
	R_{ISET} = 10.6k Ω , SOT23-6	•	\Diamond	142.5	150	157.5	^					
		V _{OUT} > 1.5V, V _{EN} = 3.3V, R _{ISET} = 10.6kΩ, SOT23-6	V _{OUT} > 1.5V, V _{EN} = 3.3V,	V _{OUT} > 1.5V, V _{EN} = 3.3V,	V _{OUT} > 1.5V, V _{EN} = 3.3V,	V _{OUT} > 1.5V, V _{EN} = 3.3V,		•	145.5	150	154.5	mA
			0	\Diamond	142.5	150	157.5					
Іоит	Output current	V_{OUT} > 1.5V, V_{EN} = 12V, R_{ISET} = 8k Ω , SOP-8-EP V_{OUT} > 1.5V, V_{EN} = 3.3V,	_	•	194	200	206					
			•	\Diamond	190	200	210					
			VOLIT> 1.5V VEN= 3.3V	VOLIT> 1.5V, VEN= 3.3V.	0	*	194	200	206	mA		
				$R_{\text{ISET}} = 8k\Omega$, SOP-8-EP		\Diamond	190	200	210			

DC CHARACTERISTICS WITH STABILIZED LED LOAD

"•" This symbol in the table means these parameters are for IS32LT3177."o" This symbol in the table means these parameters are for IS32LT3178.

Test condition is T_J= -40°C~+125°C, unless otherwise specified. (Note 7)

Symbol	Parameter	Condition		Min.	Тур.	Max.	Unit
1	Output ourrant limit	R _{ISET} = GND, V _{EN} = 12V	•		295		mΛ
lout_limit	Output current limit	R _{ISET} = GND, V _{EN} = 3.3V	0		295		mA
		V _{EN} rising	•		3.1	3.6	
Vuvlo	EN pin undervoltage lockout	VENTISHING	0		1.9	2.4	V
VUVLO	threshold	V _{EN} falling	•	2.4	2.9		v
		VEN TAILING	0	1.2	1.7		
	10mA≤I _{OUT} ≤200mA, V _{OUT} =2V		•	5		40	
V_{EN}	Sufficient supply voltage on EN pin	10mA≤l _{OUT} ≤150mA, V _{OUT} =2V, SOT23-6		2.9		5.5	V
		150mA < I _{OUT} ≤ 200mA, V _{OUT} =2V, SOP-8-EP	0	3.1		5.5	
		I _{OUT} =150mA, SOT23-6	•	1.2			
V	Minimum required headroom	I _{OUT} = 150mA, SOT23-6	0	1.2			V
V_{HR}	voltage on OUT pin	I _{OUT} = 200mA, SOP-8-EP	•	1.5			٧
		I _{OUT} = 200mA, SOP-8-EP	0	1.5			
1		$V_{OUT} > 1.5V$, $V_{EN} = 5V$, $R_{ISET} = 16k\Omega$	•			10	
ton	EN pin enabling time	$V_{OUT} > 1.5V$, $V_{EN} = 3.3V$, $R_{ISET} = 16k\Omega$	0			10	μs
T _{RO}	Thermal roll off threshold	Current decreasing slope rate: -0.6%/°C (Note 8)			145		°C
T _{SD}	Thermal shutdown threshold	Temperature rising (Note 8	8)		170		°C
T _{SD_HY}	Thermal shutdown hysteresis	Temperature falling (Note	8)		30		°C

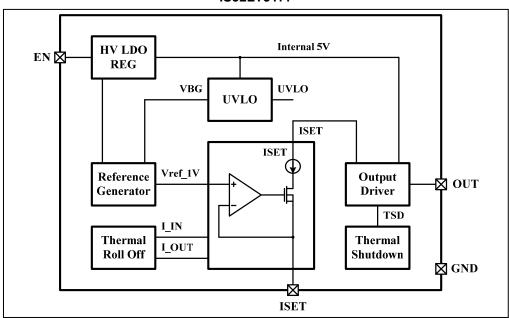
Note 7: Production testing of the device is performed at 25°C. Functional operation of the device and parameters specified over -40°C to +125°C temperature range, are guaranteed by design and characterization.

Note 8: Guaranteed by design.

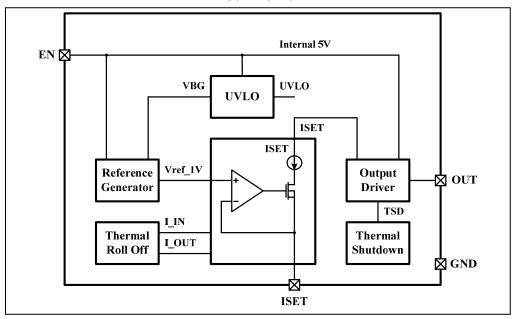


FUNCTIONAL BLOCK DIAGRAM

IS32LT3177



IS32LT3178





TYPICAL PERFORMANCE CHARACTERISTICS

IS32LT3177

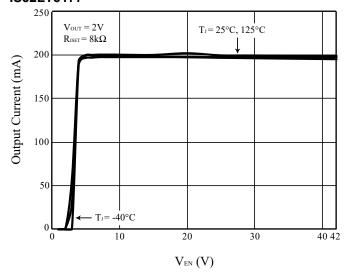


Figure 2 Output Current vs. V_{EN}

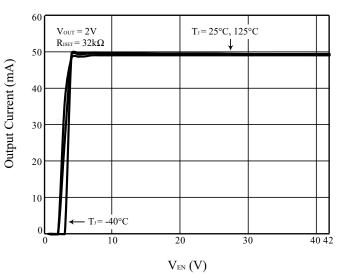


Figure 4 Output Current vs. V_{EN}

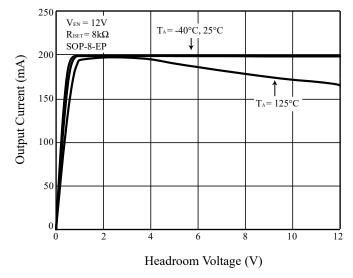


Figure 6 Output Current vs. Headroom Voltage

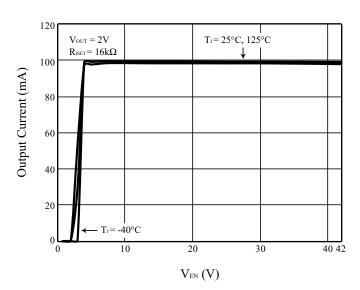


Figure 3 Output Current vs. V_{EN}

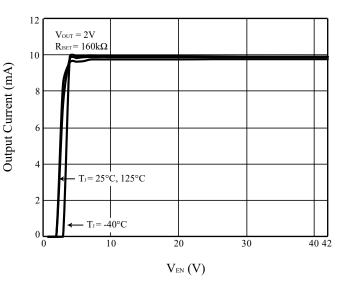


Figure 5 Output Current vs. V_{EN}

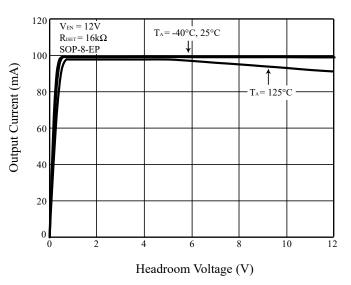


Figure 7 Output Current vs. Headroom Voltage



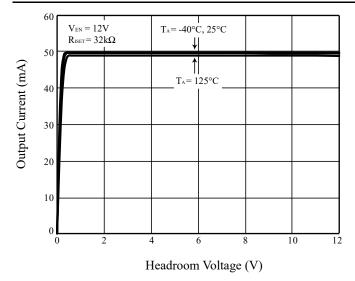


Figure 8 Output Current vs. Headroom Voltage

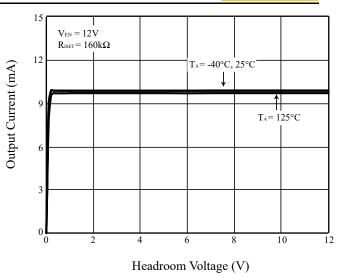


Figure 9 Output Current vs. Headroom Voltage

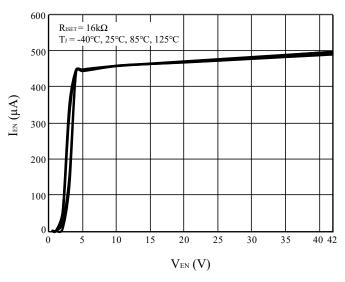


Figure 10 $\,$ I_{EN} vs. $\,$ V_{EN}

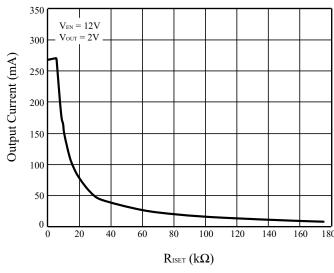


Figure 11 Output Current vs. R_{ISET}

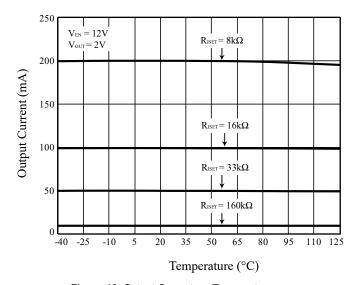


Figure 12 Output Current vs. Temperature

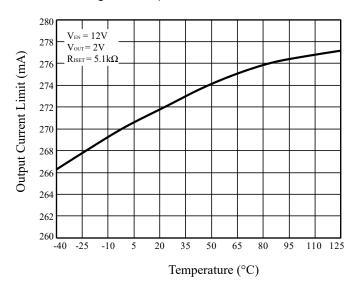


Figure 13 Output Current Limit vs. Temperature



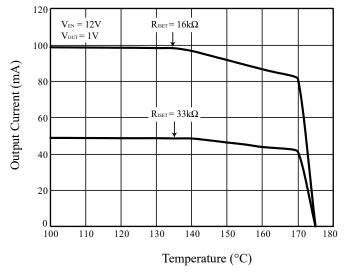


Figure 14 Output Current vs. Temperature (Thermal Roll Off)

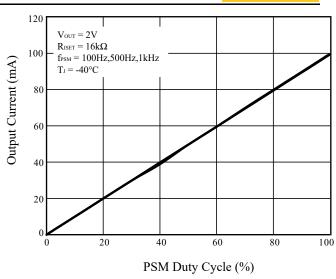


Figure 15 Output Current vs. PSM Duty Cycle

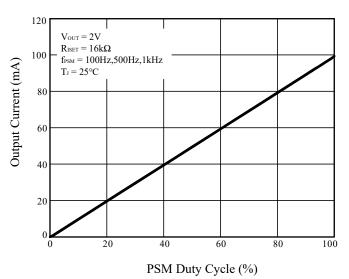


Figure 16 Output Current vs. PSM Duty Cycle

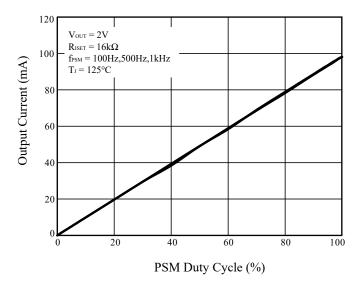


Figure 17 Output Current vs. PSM Duty Cycle

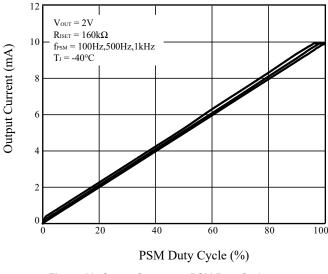


Figure 18 Output Current vs. PSM Duty Cycle

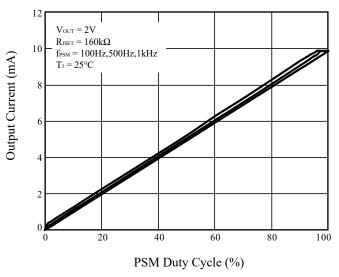
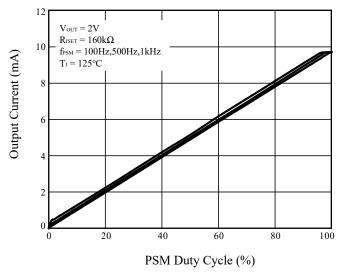


Figure 19 Output Current vs. PSM Duty Cycle





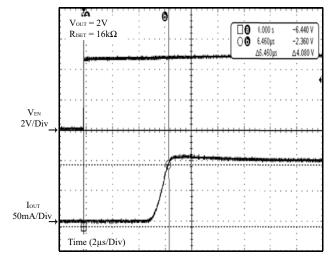


Figure 21 Start Up

Figure 20 Output Current vs. PSM Duty Cycle

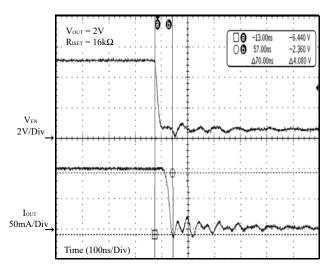
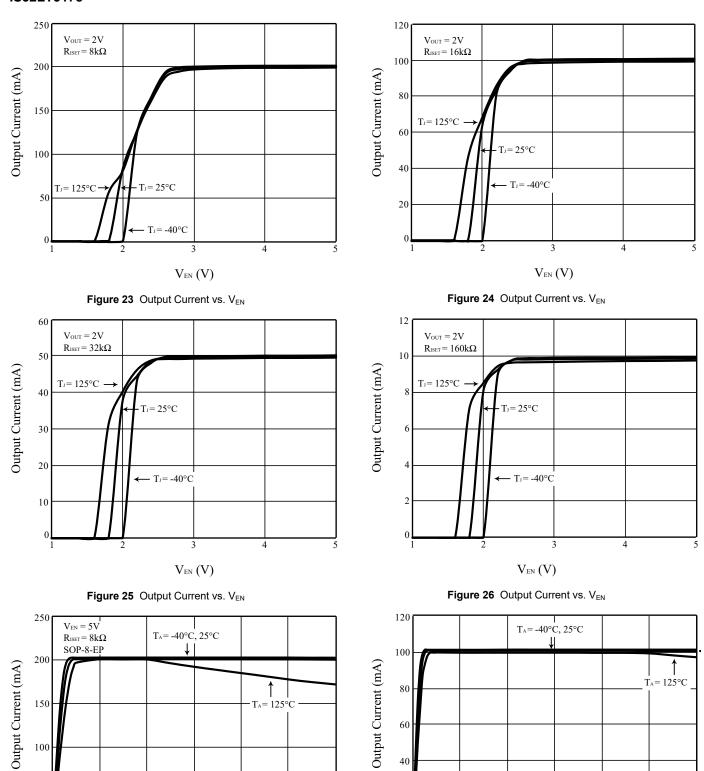


Figure 22 Shut Down



IS32LT3178



20

 $\begin{aligned} V_{\text{EN}} &= 5 V \\ R_{\text{ISET}} &= 16 k \Omega \\ SOP\text{-}8\text{-}EP \end{aligned}$

Figure 27 Output Current vs. Headroom Voltage

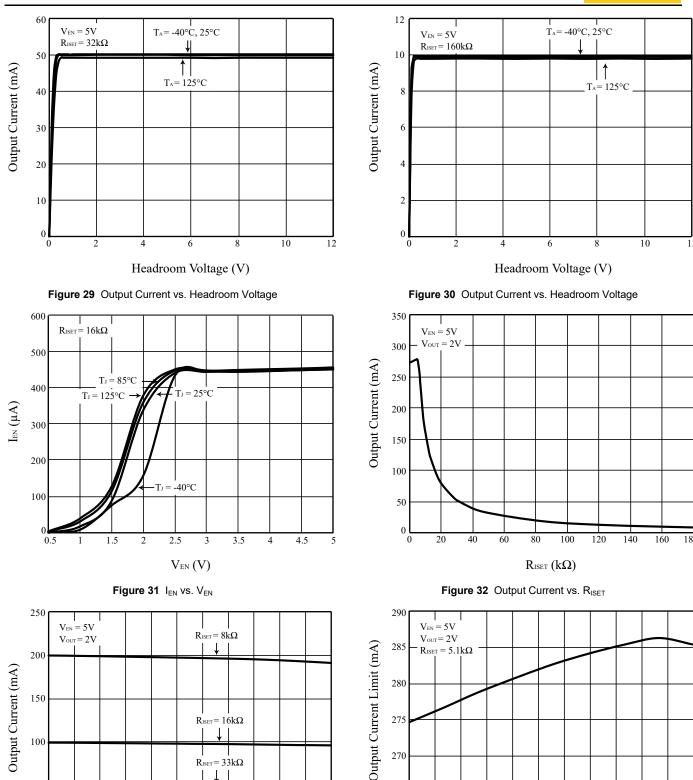
Headroom Voltage (V)

Figure 28 Output Current vs. Headroom Voltage

Headroom Voltage (V)

50





265

260

-40 -25

-10

Figure 33 Output Current vs. Temperature

 $R_{\text{ISET}}{=160k\Omega}$

Temperature (°C)

Figure 34 Output Current Limit vs. Temperature

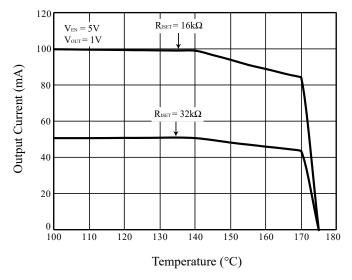
35 50 65

Temperature (°C)

50

110 125





V_{OUT} = 2V R_{ISET} = 16kΩ f_{FWM} = 100Hz, 500Hz, 1kHz T_J = -40°C

40

20

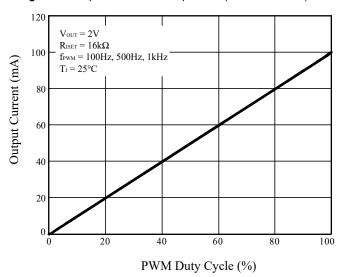
0
20
40
60
80
100

PWM Duty Cycle (%)

120

Figure 35 Output Current vs. Temperature (Thermal Roll Off)

Figure 36 Output Current vs. PWM Duty Cycle



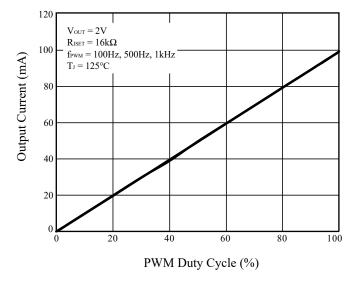
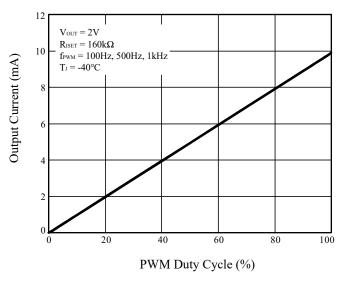


Figure 37 Output Current vs. PWM Duty Cycle

Figure 38 Output Current vs. PWM Duty Cycle



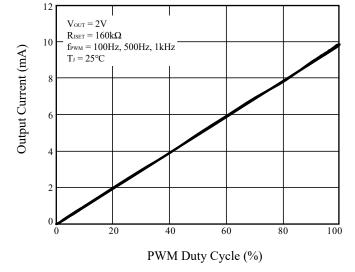
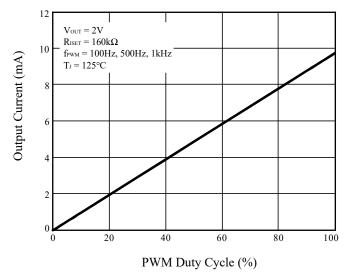


Figure 39 Output Current vs. PWM Duty Cycle

Figure 40 Output Current vs. PWM Duty Cycle





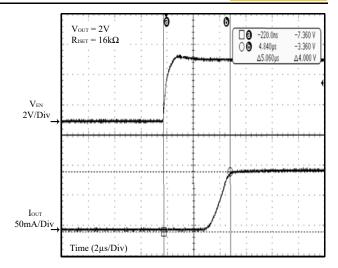
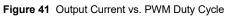


Figure 42 Start Up



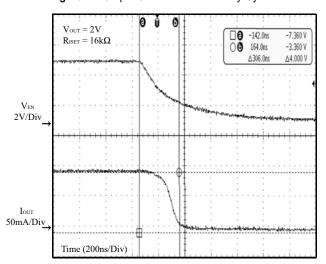


Figure 43 Shut Down



APPLICATIONS INFORMATION

IS32LT3177/78 provides an easy constant current sink solution for LED lighting applications. It uses an external resistor to adjust the LED current from 10mA to 150mA (SOT23-6)/200mA (SOP-8-EP). The LED current can be determined by the external resistor RISET as Equation (1):

$$R_{ISET} = \frac{V_{ISET} \times 1600}{I_{SET}} \tag{1}$$

10.6k Ω ≤R_{ISET}≤160k Ω for SOT23-6 package, and 8k Ω ≤R_{ISET}≤160k Ω for SOP-8-EP package.

Where R_{ISET} is in Ω , I_{SET} is desired LED current in Amp and V_{ISET} = 1.0V (Typ.)

R_{ISET} must be a 1% accuracy resistor with good temperature characteristics in order to ensure stable output current. The device limits the maximum output current to I_{OUT_LIMIT} to protect itself from an output overcurrent condition caused by a low value. Do not leave ISET pin floating.

HIGH INPUT VOLTAGE APPLICATION

When driving a long string of LEDs whose total forward voltage drop exceeds the IS32LT3177 V_{BD_OUT} limit of 40V, it is possible to stack several LEDs (such as 2 LEDs) between the EN pin and the OUT pins, and so the voltage on the EN pin is higher than 5V. The remaining string of LEDs can then be placed between power supply +Vs and EN pin, (Figure 44). The number of LEDs required to stack at EN pin will depend on the LED's forward voltage drop (V_F) and the + V_S value.

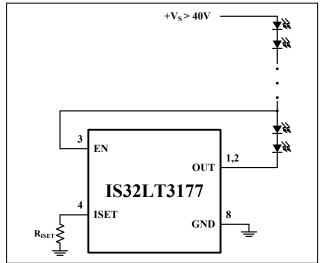


Figure 44 High Input Voltage Application Circuit

Note: when operating the IS32LT3177 at voltages exceeding the device operating limits, care needs to be taken to keep the EN pin and OUT pin voltage below 40V.

THERMAL PROTECTION AND DISSIPATION

The IS32LT3177/78 implements thermal roll off protection to reduce the LED current when the package's thermal dissipation is exceeded and prevent "thermal runaway". The thermal roll off begins from 145°C, and linearly decreases following the junction temp to 85% of the set current value at T_{SD} (170°C). Please see Figure 14 and 35. In the event that the junction temperature exceeds 170°C, the device will go into shutdown mode. At this point, the IC begins to cool off and will resume operation once the junction temperature goes below 140°C.

When operating the chip at high ambient temperatures, or when driving maximum load current, care must be taken to avoid exceeding the package power dissipation limits. Exceeding the package dissipation will cause the device to enter thermal protection mode. The maximum package power dissipation can be calculated using the following Equation (2):

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$
 (2)

Where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance; a metric for the relative thermal performance of a package.

The recommended maximum operating junction temperature, $T_{J(MAX)}$, is 125°C and so the maximum ambient temperature is determined by the package parameter; θ_{JA} . The θ_{JA} for the IS32LT3177/78 SOT23-6 package is 130°C/W and SOP-8-EP package is 43.1°C/W.

Therefore the maximum power dissipation at T_A = 25°C is:

$$P_{D(MAX)} = \frac{125^{\circ}C - 25^{\circ}C}{130^{\circ}C/W} \approx 0.77W \text{ (SOT23-6)}$$

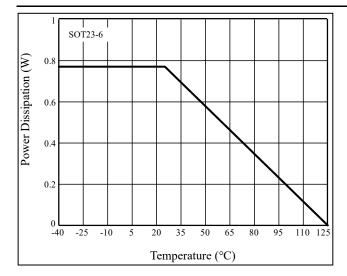
$$P_{D(MAX)} = \frac{125^{\circ}C - 25^{\circ}C}{43.1^{\circ}C/W} \approx 2.32W \text{ (SOP-8-EP)}$$

The actual power dissipation P_D is:

$$P_D = V_{OUT} \times I_{OUT} + V_{EN} \times I_{EN}$$
 (3)

To ensure optimum performance, the die temperature (T_J) of the IS32LT3177/78 should not exceed 125°C. The graph below gives details for the package power derating.





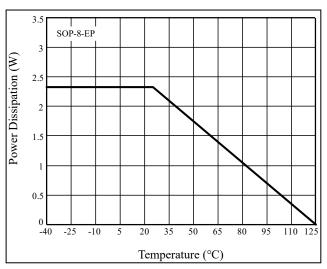
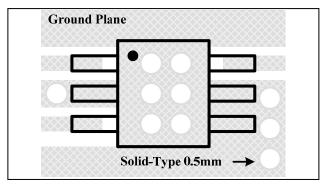


Figure 45 PD vs. TA

A lower thermal resistance is achieved by mounting the IS32LT3177/78 on a standard FR4 double-sided printed circuit board (PCB) with a grounded copper area of a few square inches on each side of the board under the IS32LT3177/78. Multiple thermal solid vias (not web or spoke type), as shown in Figure 46, help to conduct heat from the exposed pad of the IS32LT3177/78 to the grounded copper area on each side of the board. The recommended via diameter is 0.5mm with spacing of 1mm. The thermal resistance can be further reduced by using a metal-clad PCB or by adding a heatsink.



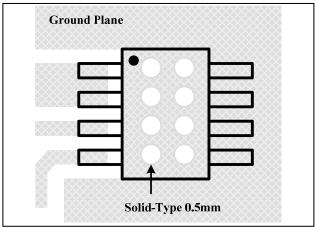


Figure 46 Board Via Layout For Thermal Dissipation



CLASSIFICATION REFLOW PROFILES

Profile Feature	Pb-Free Assembly		
Preheat & Soak	150°C		
Temperature min (Tsmin)	150°C 200°C		
Temperature max (Tsmax)	60-120 seconds		
Time (Tsmin to Tsmax) (ts)	00-120 seconds		
Average ramp-up rate (Tsmax to Tp)	3°C/second max.		
Liquidous temperature (TL)	217°C		
Time at liquidous (tL)	60-150 seconds		
Peak package body temperature (Tp)*	Max 260°C		
Time (tp)** within 5°C of the specified	Max 30 seconds		
classification temperature (Tc)	Max 30 seconds		
Average ramp-down rate (Tp to Tsmax)	6°C/second max.		
Time 25°C to peak temperature	8 minutes max.		

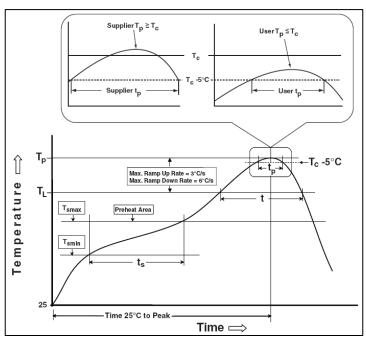
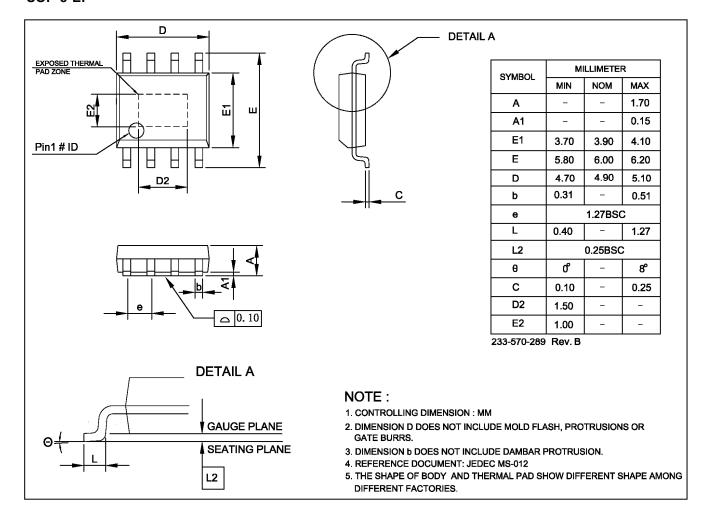


Figure 47 Classification Profile



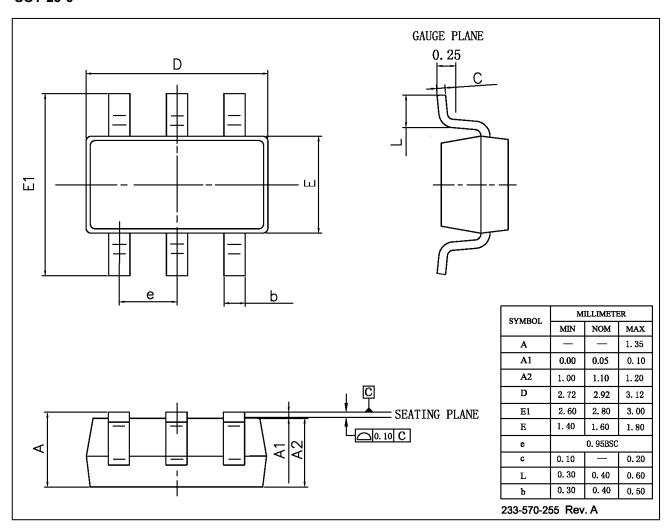
PACKAGE INFORMATION

SOP-8-EP





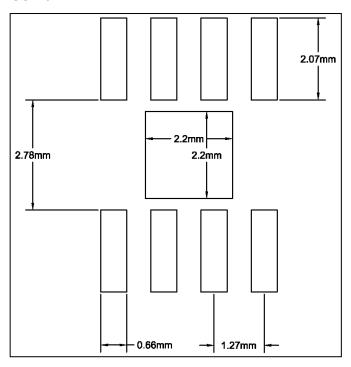
SOT-23-6



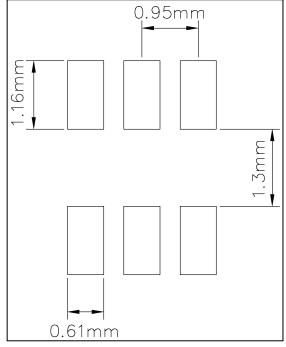


RECOMMENDED LAND PATTERN

SOP-8-EP



SOT-23-6



Note:

- 1. Land pattern complies to IPC-7851.
- 2. All dimensions in MM.
- 3. This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown (eg. User's board manufacturing specs), user must determine suitability for use.



REVISION HISTORY

Revision	Detail Information	Date
0A	Initial release	2018.08.06
0B	Update FEATURES information Update SOP-8-EP POD Update V _{EN} value	2018.11.20
А	Add note 4 for Figure 1 Update EC table	2019.04.03
В	Revise I _{OUT_LIMIT} typical value to 295mA	2020.09.25
С	Update to new Lumissil logo Add RoHS and update AECQ information EC condition "T _J = T _A = " changes to "T _J ="	2024.06.06



ALUMINIUM HOUSED POWER RESISTORS

TYPE HS SERIES

INTRODUCTION

TE Connectivity (TE) is one of the leading European suppliers of standard and custom designed aluminium housed resistors for general-purpose use, power supplies, power generation and the traction and drives industries. The HS Series product offering, a range of extremely stable, high-quality wire wound resistors are made from quality materials for optimum reliability and stability, capable of dissipating high power in a limited space with relatively low surface temperature. The aluminium housing in these resistors help rapidly dissipate power to a specified heat sink.



This latest revision of the datasheet introduces two new additions to the series: the HSCS stud terminal type HSC75, 100, and 150, and the HSHC type with power ratings from 350W to 500W, giving this series the widest range of power ratings currently on offer. TE is happy to advise on the use of these resistors for pulse applications and high voltage use. On request, TE can modify and test these resistors specifically to conform to relevant international, military or customer specifications. Low ohmic values, alternative mountings, and alternative termination types are also available on request.

FEATURES

- Established product with proven reliability leading the way with over 50 years of design and manufacturing experience.
- 5 Watts to 500 Watts: Largest range on the market.
- Versatile product bench mark in wide range of industries.
- Custom designs, windings, terminations, mountings available on request.
- Low resistance, low inductance and higher voltage versions available specialising the standard.

APPLICATIONS

- Braking resistor
- Balancing resistor
- Capacitor charging & discharging
- Crowbar
- Filter
- Electrical machinery general use

CHARACTERISTICS - ELECTRICAL HSA & HSC - 5 Watts to 75 Watts

	HSA5	HSA10	HSA25	HSA50	HSC75		
Dissipation @ 25°C with heatsink (Watts):	10	16	25	50	75		
Without heatsink (Watts):	5.5	8	12.5	20	45		
Ohmic value minimum (Ohms):	R01	R01	R01	R01	R05		
Ohmic value maximum (Ohms):	10K	15K	36K	100K	50K		
Operating temperature	-55-200°C						
Maximum working voltage (DC or AC rms) Volts:	150	250	500	1250	1400		
Isolation voltage (DC or AC pk) Volts:	1400	1400	2500	2500	3500		
Dielectric strength (AC Peak) Volts:	1400	1400	2500	2500	5000		
Stability (resistance change, 1000 hours) (%):	1	1	1	1	2		
Standard heatsink - area (mm²):	41500	41500	53500	53500	99500		
Thickness (mm):	1	1	1	1	3		
Number of mounting holes:	2 hole	2 hole	2 hole	2 hole	4 hole		

Aluminium Housed Power Resistors

Type HS Series

HSC - 100 Watts to 300 Watts

	HSC100	HSC150	HSC200	HSC250	HSC300			
Dissipation @ 25°C with heatsink (Watts):	100	150	200	250	300			
Without heatsink:	50	55	50	60	75			
Ohmic value minimum (Ohms):	R05	R10	R10	R10	R10			
Maximum (Ohms):	100K	100K	50K	68K	82K			
Operating temperature	-55-200°C							
Maximum working voltage (DC or AC rms) Volts:	1900	2500	1900	2200	2500			
Isolation voltage (DC or AC pk) Volts:	3500	3500	3600	3600	3600			
Dielectric strength (AC Peak) Volts:	5000	5000	5600	5600	5600			
Stability (resistance change, 1000 hours) (%):	2	2	3	3	3			
Standard heatsink - area (mm²):	99500	99500	375000	476500	578000			
Thickness (mm):	3	3	3	3	3			
Number of mounting holes:	4 hole	4 hole	6 hole	6 hole	6 hole			

HSHC - 350 Watts to 500 Watts

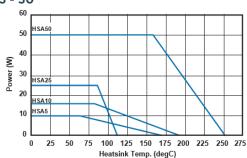
	HSHC350	HSHC400	HSHC450	HSHC500				
Dissipation @ 25°C with heatsink (Watts):	350	400	450	500				
Without heatsink (Watts):	85	100	110	125				
Ohmic value minimum (Ohms):	1R0	1R0	1R0	1R0				
Maximum (Ohms):	100K	100K	100K	100K				
Operating temperature		-55-200°C						
Maximum working voltage (DC or AC rms) Volts:	2500	2500	2500	2500				
Isolation voltage (DC or AC pk) Volts:	3600	3600	3600	3600				
Dielectric strength (AC Peak) Volts:	5000	5000	5000	5000				
Stability (resistance change, 1000 hours) (%):	3	3	3	3				
Standard heatsink - area (mm²):	578000	578000	578000	578000				
Thickness (mm):	3	3	3	3				
Number of mounting holes:	6 hole	6 hole	6 hole	6 hole				

Long term stability	For improvements in long-term stability, resistors must be derated as follows: for 50% of stated ΔR maximum dissipation must not exceed 70% of rating: for 25% of stated ΔR maximum, dissipation must not exceed 50% of rating.
Insulation resistance	Dry: 10,000M Ω minimum. After moisture test: 1000M Ω minimum
Heat dissipation	Although the use of proprietary heat sinks with lower thermal resistance is acceptable, up rating is not recommended. The use of proprietary heat sink compound to improve thermal conductivity is recommended for optimum performance of all sizes but essential for higher power ratings (200W and higher)
Resistance tolerance	±5% Standard. Other options on request.
Specification	Temperature coefficient of resistance: ≤100R, ±50ppm/°C; >100R, ±25ppm/°C Tolerance, 5% standard: 10%, 3%, 2%, 0.5% & 0.25% available Tolerance for values below R10, 10% standard
Shelf life	24 Months when stored in original packaging away from chemical pollution

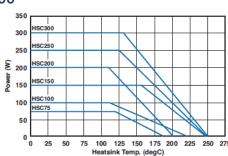
DERATING CURVE

N.B. The graphs plot power against allowable heatsink temperature range and not the temperature the heatsink will rise to under this power condition, nor the ambient temperature.

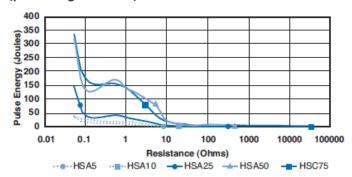
HSA5 - 50



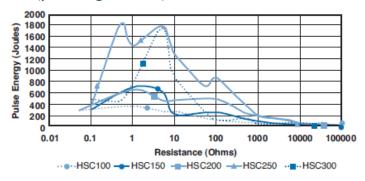
HSC75 - 300



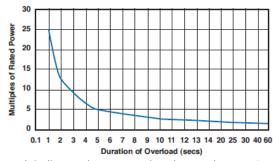
Pulse Energy HSA5 to HSC75 (pulse length 200ms)



Pulse Energy HSC100 to HSC300 (pulse length 200ms)

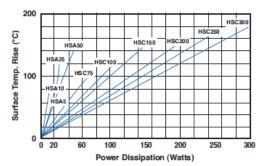


Power Overload



This graph indicates the amount that the rated power (at 20°C) of the standard HS series resistor may be increased for overloads of 100mS to 60S $\,$

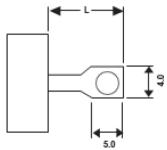
Surface Temperature Rise



For resistor mounted on standard heatsink, related to power dissipation

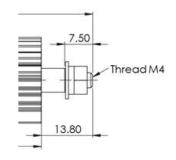
PRODUCT SPECIFICATIONS (Unit:mm)

HSA5 - HSC150 Standard

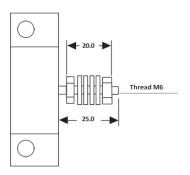


;	5.0
Standard Type	L
HSA5, 10	7
HSA25, 50	10
HSC75, 100, 150	8

HSC75S - HSC150S

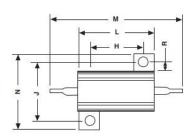


HSC200 - HSC300 & HSHC350 - HSHC500



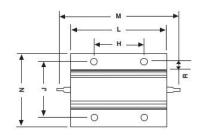
DIMENSIONS (Unit:mm)

HSA5 - HSA50



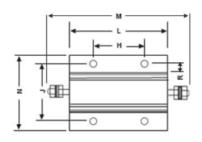
HSA5 - HSA10 : Mounting Hole 2 x 2.4mm **HSA25 - HSA50** : Mounting Hole 2 x 3.3mm

HSC75 - HSC150



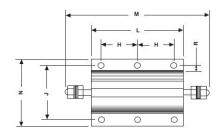
HSC75 - HSC150: Mounting Hole 4 x 4.4mm

HSC75S - HSC150S



HSC75 - HSC150: Mounting Hole 4 x 4.4mm

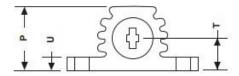
HSC300 - HSC300, HSHC350 - HSHC500



HSC200 - HSC250 : Mounting Hole 2 x 2.4mm **HSC300, HSHC350 - HSHC500** : Mounting Hole 2 x 3.3mm

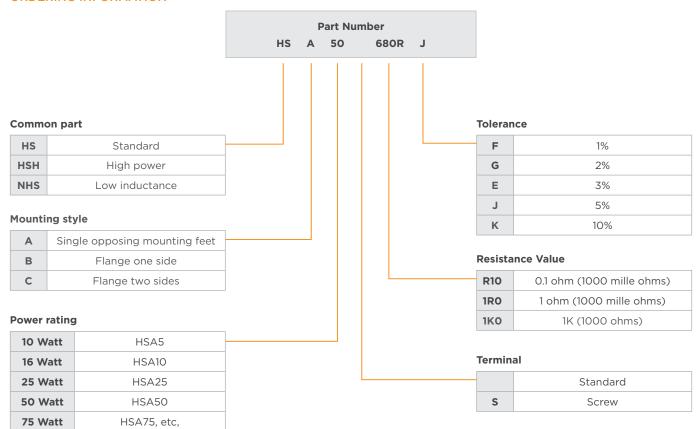
DIMENSIONS (continued)

End Elevation (all models)



Туре	H ±0.3	J ±0.3	L maximum	M maximum	N maximum	P maximum	R minimum	T±0.5	U maximum
HSA5	11.3	12.4	17.0	30.0	17.0	9.0	1.9	4.3	2.5
HSA10	14.3	15.9	21.0	36.5	21.0	11.0	1.9	5.2	3.2
HSA25	18.3	19.8	29.0	51.0	28.0	15.0	2.8	7.2	3.2
HSA50	39.7	21.4	51.0	72.5	30.0	17.0	2.8	8.2	3.2
HSC75	29.0	37.0	49.0	71.0	48.0	24.0	5.0	11.5	3.5
HSC100	35.0	37.0	66.0	87.5	48.0	24.0	5.0	11.5	3.5
HSC150	58.0	37.0	98.0	122.0	48.0	24.0	5.0	11.5	3.5
HSC200	35.0	57.2	90.0	143.0	73.0	42.0	5.6	20.25	5.3
HSC250	44.5	57.2	109.0	163.0	73.0	42.0	5.6	20.25	5.3
HSC300	52.0	59.0	128.0	180.0	73.0	42.0	5.6	20.25	5.3
HSC75S	29.0	37.0	49.0	78.0	48.0	24.0	5.0	11.5	3.5
HSC100S	35.0	37.0	66.0	94.0	48.0	24.0	5.0	11.5	3.5
HSC150S	58.0	37.0	98.0	127.0	48.0	24.0	5.0	11.5	3.5
HSHC350	61.50	59.0	147	196.0	73	42.0	5.6	20.25	5.3
HSHC400	71.0	59.0	166	215.0	73	42.0	5.6	20.25	5.3
HSHC450	80.5	59.0	185	234.0	73	42.0	5.6	20.25	5.3
HSHC500	90.0	59.0	204	253.0	73	42.0	5.6	20.25	5.3

ORDERING INFORMATION



te.com

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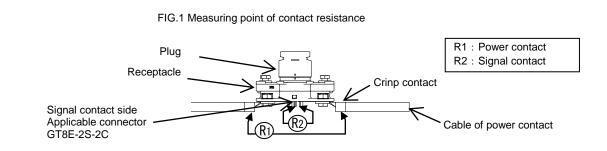
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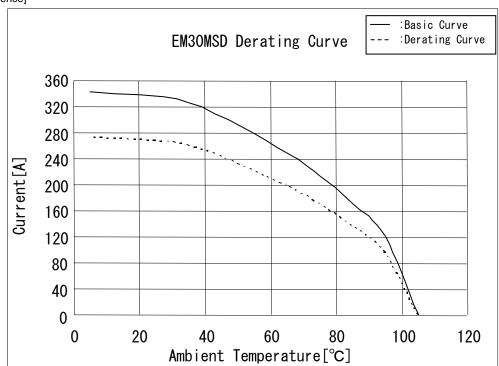
1773035 Rev. E 04/24 ED



APPLICAB	LE STA	NDAR	lD.	TÜV approved (J503853	364). UL	_ appro\	/ed (E	174564).				
	Operati	ing		-40 °C to +105 °C				mperature		10°C to 160	0°C	
	Temperature Range		Range			Range		,		-10°C to +60	, 0	
Rating Voltage		Э		Power Contact : AC/DC Signal Contact : AC/DC		_						
			Power Contact : 200 A		P	Applicab	le Cable		100 mm ² mir	1		
Current			Signal Contact : 1	Α		.ppoa.			(AWG#4/0 mi	-		
				SPEC	CIFICA	TION	S					
	ГЕМ			TEST METHOD					FOLI	IREMENTS	QT	AT
CONSTRU				TEST WETTOD				- N	LQU	IKLIVILIVIS	QI	AI
General Exam			Evaminad	visually and with a measuring in	etrument		T				Х	Х
	iiialioii			, ,	istrument.		Accordi	ng to the d	rawin] .	X	
Marking	AL CH		Confirmed	,							Χ.	Х
ELECTRICAL CHARACT						1				X	Х	
Contact Resistance ₍₂₎		ŀ		at DC 1A.(Power contact)			0.5 mΩ MAX.				X	_ ^
				at DC 1A.(Signal contact include	e GT8E-2	S-2C)	90 mΩ					
				at 500 V DC. c applied for 1 min. (Power conta	act)		No brea	MΩ MIN.			X	X
voltage F1001							INO DIES	IKUUWII.			X	X
MECHANI		IADAC		applied for 1 min. (Signal conta	act)							
							Mating	and unmati	ing for	ces: 100 N MAX.	Х	1_
Mating and Ur	nmating Fo			with an applicable connector.			_		•	Plug and Receptacle)	^	
			vvithout lo	cking device.			1			75 mΩ MAX. (Power contact)	X	-
			Mated and	unmated 200 times.						0 mΩ MAX. (Power contact)	^	-
Mechanical O	neration		(Between	EM30MSD-A Plug and Receptage	cle)			ontact incled				
iviocriariloar O	poration		Mated and	unmated 30 times.			` `			50 mΩ MAX	Х	
				EM30MSD-A Receptacle and G	T8E-2S-20	C)	(Signal c	ontact incled	de GT8	E-2S-2C)		
Vibration 1			Frequency	· · · · · · · · · · · · · · · · · · ·						nuity of more than 10 μs.		
			Single am	olitude: 0.75 mm			2) No da	amage, cra	acks o	r looseness of parts.	Х	-
			Performed	over 10 cycles in each of three	mutually							
			perpendicu	ular directions.								
(ICO467E0 2 / IACO D 044 2)			Frequency: 10 TO 2000 (Hz),					1) No electrical discontinuity of more than 10 μs.				
ACC		Acceleration spectrum density : 57.9 m/s ² , At 8 h, for 3 directions.					2) No damage, cracks or looseness of parts.					
Shock				on: 490 m/s ² , Half sine wave pul	ses of 11	ms	1) No el	lectrical dis	contir	nuity of more than 10 µs.		
				rformed 3 times in each of three mutually perpendicular			1			r looseness of parts.	Х	_
			directions.	o umoo m cach or umoo mataa	., po.po			amago, oro		. reconnect or parter		
ENVIRON	MENTAI			RISTICS			I					
				ure: -40 \rightarrow R/T ⁽¹⁾ \rightarrow +125 \rightarrow R	/T °C		1) Insula	ation resist	ance:	5000 MΩ MIN.	Х	_
rapia oriange	, o opc		•	\rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3 min			2) No da	amage, cra	acks o	r looseness of parts.		
			for 5 cycles									
Damp Heat, S	teady Stat			to a temperature of +40°C, at a	humidity o	of 90 to	1) Insula	1) Insulation resistance: 50 MΩ MIN.				
Damp Hoat, C	iouu, oiai		95% for 96	•		5. 00 10	(At high humidity)2) Insulation resistance: 500 MΩ MIN. (When dry)3) No damage, cracks or looseness of parts.					
			007010100	, riouro.								
												<u> </u>
Corrosion Salt	t Mist(4)		Subjected	to 5% salt spray for 48 hours.			No heav	vy corrosio	n whic	ch impairs functionality.	X	
Sealing(4)			Subjected	to a depth of 2 m for 14 days.			No wate	No water penetration into the connector.				-
			(IPX8 Wat	erproof)(JIS C 0920:2003)							\perp	
Air Tightness(4)		17.6 kPa c	kPa of air pressure applied to the inside of the mated				No air bubbles emitted from the inside of the				
			connector	for 30 seconds.			connect	tor.			Х	-
					1						1	
COUN	IT	DE	SCRIPTION	ON OF REVISIONS		DESIG	SNED			CHECKED	D/	ATE
⚠											\perp	
REMARK								APPRO	VED	TP. KOMATSU	202	20808
Notes (1) R/T	: Room T	emperat	ure									
(2) Measured contact resistance at the points shown in Fig.1 on the next page.				١.		CHECK	(ED	HY. KOBAYASHI	202	20808		
(3) Delaying curve shown in Fig.2 on the next page.					DESIGNED TV 9171		TV CHTIVI	200	20005			
(4) Corrosion salt mist, Sealing and Air tightness shall be tested under mated condition				DESIGNED T		TY. SUZUKI	202	20805				
with an applicable connector.												
(5) Ope	erating tem	nperturte	range incl	udes the temperature rise by cu	rrent carry	ring.	DRAWN		TY. SUZUKI	202	20805	
Unless otherwise specified refer to IEC 60512 (IIS			C 5402))	11. 30201			552311	20220			
Unless otherwise specified, refer to IEC 60512 (JIS C 5402).				ĺ				ELO 440E40	04.5	^		
Note QT:C)ualificati	ion Tes	t AT:As	surance Test X:Applicab	le Test	DI	DRAWING NO. ELC-119542			<u>04–</u> 0	0	
שכ		SE	FCIFI	CATION SHEET		PART			EM30MSD-A (04)			
HS.									010	<u> </u>		1 10
		חות	JOE EI	ECTRIC CO., LTD.		CODE	NO.	UL	υIJ	8-0206-0-04	Δ	1/2
OPM HOOG11												



[Reference]



Measurement method:

Mated plug and receptacle with 100 mm² cable.

Note:

Derating curve could vary depending on cable type and each measurement even under the same conditions.

Therefore, above data are guidelines and not connector specifications.

Note QT:Qu	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC-119542-04-00		
RS	SPECIFICATION SHEET	PART NO.		EM30MSD-A (04)		
1.0	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL013	8-0206-0-04	Δ	2/2



Reference

[1] TE ECK100BH5AAA Datasheet. www.te.com, 11.2024